

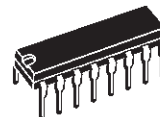
## PRIMARY CONTROLLER

- CURRENT-MODE CONTROL PWM
- SWITCHING FREQUENCY UP TO 1MHz
- LOW START-UP CURRENT < 0.45mA
- HIGH-CURRENT OUTPUT DRIVE SUITABLE FOR POWER MOSFET (1A)
- FULLY LATCHED PWM LOGIC WITH DOUBLE PULSE SUPPRESSION
- PROGRAMMABLE DUTY CYCLE
- 100% AND 50% MAXIMUM DUTY CYCLE LIMIT
- PROGRAMMABLE SOFT START
- PRIMARY OVERCURRENT FAULT DETECTION WITH RE-START DELAY
- PWM UVLO WITH HYSTERESIS
- IN/OUT SYNCHRONIZATION
- DISABLE LATCHED
- INTERNAL 100ns LEADING EDGE BLANKING OF CURRENT SENSE
- PACKAGE: DIP16 AND SO16W

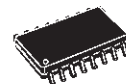
### DESCRIPTION

This primary controller I.C., developed in BCD60II technology, has been designed to implement off

### MULTIPOWER BCD TECHNOLOGY



DIP16



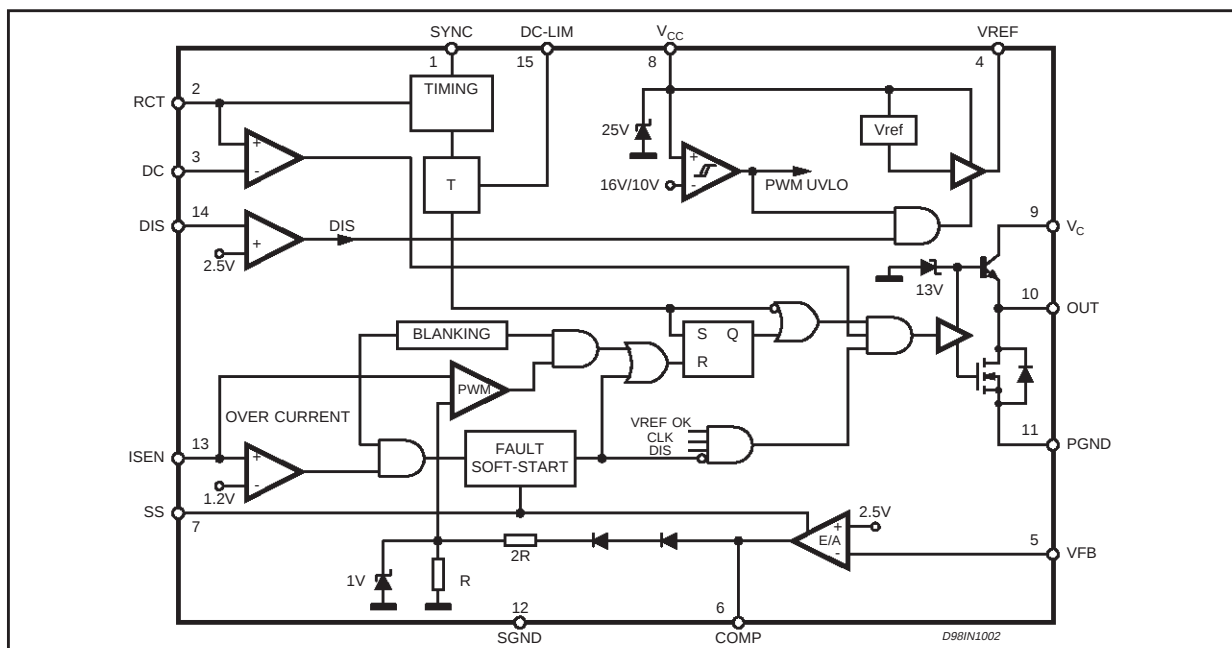
SO16W

**ORDERING NUMBERS:** L4990/L4990A(DIP16)  
L4990D/L4990AD (SO16W)

line or DC-DC power supply applications using a fixed frequency current mode control.

Based on a standard current mode PWM controller this device includes some features as programmable soft start, IN/OUT synchronization, disable (to be used for over voltage protection and for power management), precise maximum Duty Cycle Control, 100ns (typ) leading edge blanking on current sense, pulse by pulse current limit and overcurrent protection with soft start intervention.

### BLOCK DIAGRAM

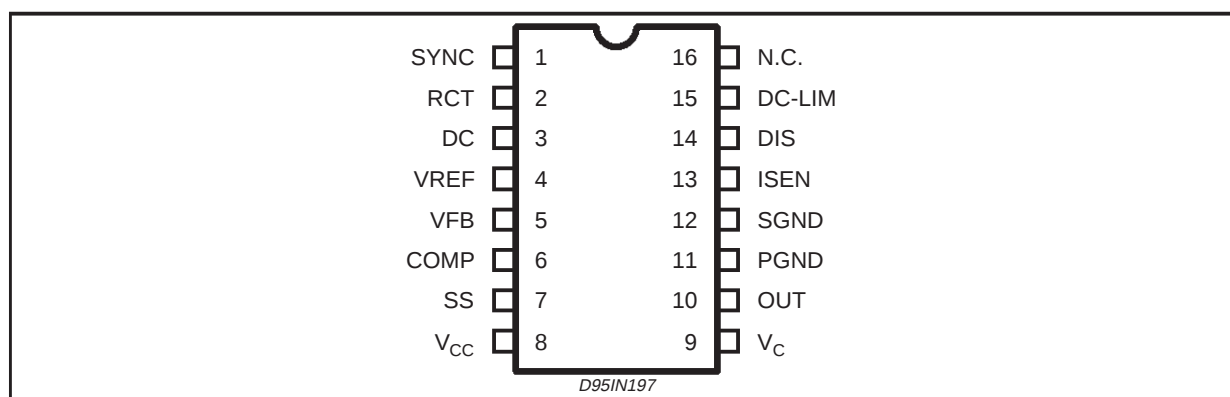


## ABSOLUTE MAXIMUM RATINGS

| Symbol           | Parameter                                    | Value      | Unit |
|------------------|----------------------------------------------|------------|------|
| V <sub>CC</sub>  | Supply Voltage (I <sub>CC</sub> < 50mA) (*)  | selflimit  | V    |
| I <sub>OUT</sub> | Output Peak Pulse Current                    | 1.5        | A    |
|                  | Analog Inputs & Outputs (6,7)                | -0.3 to 8  | V    |
|                  | Analog Inputs & Outputs (1,2,3,4,5,15,14 13) | -0.3 to 6  | V    |
| P <sub>tot</sub> | Power Dissipation @ T <sub>amb</sub> = 70°C  | 1          | W    |
| T <sub>j</sub>   | Junction Temperature, Operating Range        | -25 to 125 | °C   |
| T <sub>stg</sub> | Storage Temperature, Operating Range         | -55 to 150 | °C   |

(\*) maximum package power dissipation limits must be observed

## PIN CONNECTION



## THERMAL DATA

| Symbol                | Parameter                                           | Value | Unit |
|-----------------------|-----------------------------------------------------|-------|------|
| R <sub>th j-amb</sub> | Thermal Resistance Junction to Ambient <b>DIP16</b> | 80    | °C/W |
| R <sub>th j-amb</sub> | Thermal Resistance Junction to Ambient <b>SO16</b>  | 120   | °C/W |

## PIN FUNCTIONS

| N. | Name            | Function                                                                                                       |
|----|-----------------|----------------------------------------------------------------------------------------------------------------|
| 1  | SYNC            | Synchronization. A synchronization pulse terminates the PWM cycle and discharges Ct                            |
| 2  | RCT             | Oscillator pin for external C <sub>t</sub> , R <sub>t</sub> components                                         |
| 3  | DC              | Duty Cycle control                                                                                             |
| 4  | VREF            | 5.0V +/-1.5% reference voltage                                                                                 |
| 5  | VFB             | Error Amplifier Inverting input                                                                                |
| 6  | COMP            | Error Amplifier Output                                                                                         |
| 7  | SS              | Soft start pin for external capacitor C <sub>ss</sub>                                                          |
| 8  | V <sub>CC</sub> | Supply for internal "Signal" circuitry                                                                         |
| 9  | V <sub>c</sub>  | Supply for Power section                                                                                       |
| 10 | OUT             | High current totem pole output                                                                                 |
| 11 | PGND            | Power ground                                                                                                   |
| 12 | SGND            | Signal ground                                                                                                  |
| 13 | ISEN            | Current sense                                                                                                  |
| 14 | DIS             | Disable. It must never be left floating. Tie to SGND if not used.                                              |
| 15 | DC-LIM          | Connecting this pin to Vref, DC is limited to 50%. If it is left floating or grounded no limitation is imposed |
| 16 | NC              | Not connected                                                                                                  |

**ELECTRICAL CHARACTERISTICS** ( $V_{CC} = 15V$ ;  $T_j = 0$  to  $70^\circ C$ ; unless otherwise specified.)

| Symbol                           | Parameter                | Test Condition                                                                                     | Min.     | Typ. | Max.   | Unit           |
|----------------------------------|--------------------------|----------------------------------------------------------------------------------------------------|----------|------|--------|----------------|
| <b>REFERENCE SECTION</b>         |                          |                                                                                                    |          |      |        |                |
| $V_O$                            | Output Voltage           | $T_j = 25^\circ C$ ; $I_O = 1mA$                                                                   | 4.925    | 5.0  | 5.075  | V              |
|                                  | Line Regulation          | $V_{CC} = 12$ to $20V$                                                                             |          | 2.0  | 15     | mV             |
|                                  | Load Regulation          | $I_O = 1$ to $20mA$                                                                                |          | 5.0  | 20     | mV             |
| $T_S$                            | Temperature Stability    |                                                                                                    |          | 0.4  |        | mV/ $^\circ C$ |
|                                  | Total Variation          | Line, Load, Temperature                                                                            | 4.875    | 5.0  | 5.125  | V              |
| $I_{OS}$                         | Short Circuit Current    | $V_{ref} = 0V$                                                                                     | 30       |      | 150    | mA             |
|                                  | Power Down/UVLO          | $V_{CC} = 8.5V$ ; $I_{sink} = 0.5mA$                                                               |          | 0.2  | 0.5    | V              |
| <b>OSCILLATOR SECTION</b>        |                          |                                                                                                    |          |      |        |                |
|                                  | Initial Accuracy         | $T_j = 25^\circ C$ ; $R_T = 4.42k\Omega$ ; $C_T = 1nF$ ; pin 15 $V_{ref}$                          | 285      | 300  | 315    | kHz            |
|                                  | Accuracy                 | $R_T = 4.42k\Omega$ ; $V_{CC} = 12$ to $20V$ ; $C_T = 1nF$ ; pin 15 = $V_{ref}$                    | 279      | 300  | 321    | kHz            |
|                                  | Initial Accuracy         | $T_j = 25^\circ C$ ; $R_T = 4.42k\Omega$ ; $C_T = 1nF$ ; pin 15 OPEN                               | 280      | 295  | 310    | kHz            |
|                                  | Accuracy                 | $R_T = 4.42k\Omega$ ; $V_{CC} = 12$ to $20V$ ; $C_T = 1nF$ ; pin 15 OPEN                           | 275      | 295  | 315    | kHz            |
|                                  | Duty Cycle               | pin 3 = 0.7V, pin 15 = $V_{ref}$<br>pin 3 = 0.7V, pin 15 = OPEN                                    |          |      | 0<br>0 | %<br>%         |
|                                  | Duty Cycle               | $R_T = 4.42k\Omega$ $C_T = 1nF$<br>pin 3 = 3.2V, pin 15 = $V_{ref}$<br>pin 3 = 3.2V, pin 15 = OPEN | 45<br>90 |      |        | %<br>%         |
|                                  | Duty Cycle Accuracy      | pin 3 = 2.02V, pin 15 = OPEN                                                                       | 37       | 40   | 43     | %              |
|                                  | Oscillator Ramp Peak     |                                                                                                    |          | 3.0  |        | V              |
|                                  | Oscillator Ramp Valley   |                                                                                                    |          | 1.0  |        | V              |
| <b>ERROR AMPLIFIER SECTION</b>   |                          |                                                                                                    |          |      |        |                |
|                                  | Input Bias Current       | $V_{FB}$ to GND                                                                                    |          | 0.2  | 1.0    | $\mu A$        |
| $V_I$                            | Input Voltage            | $V_{COMP} = V_{FB}$                                                                                | 2.42     | 2.5  | 2.58   | V              |
| $G_{OPL}$                        | Open Loop Gain           | $V_{COMP} = 2$ to $4V$                                                                             | 60       | 90   |        | dB             |
| SVR                              | Supply Voltage Rejection | $V_{CC} = 12$ to $20V$                                                                             |          | 85   |        | dB             |
| $V_{OL}$                         | Output Low Voltage       | $I_{sink} = 2mA$ , $V_{FB} = 2.7V$                                                                 |          |      | 1.1    | V              |
| $V_{OH}$                         | Output High Voltage      | $I_{source} = 0.5mA$ , $V_{FB} = 2.3V$                                                             | 5        | 6    |        | V              |
| $I_O$                            | Output Source Current    | $V_{COMP} > 4V$ , $V_{FB} = 2.3V$                                                                  | 0.5      | 1.3  |        | mA             |
|                                  | Output Sink Current      | $V_{COMP} = 1.1V$ , $V_{FB} = 2.7V$                                                                | 2        | 6    |        | mA             |
|                                  | Unit Gain Bandwidth      |                                                                                                    | 2        | 4    |        | MHz            |
| $S_R$                            | Slew Rate                |                                                                                                    |          | 8    |        | V/ $\mu s$     |
| <b>PWM CURRENT SENSE SECTION</b> |                          |                                                                                                    |          |      |        |                |
| $I_b$                            | Input Bias Current       | $I_{sen} = 0$                                                                                      |          | 3    | 15     | $\mu A$        |
| $I_S$                            | Maximum Input Signal     | $V_{COMP} = 5V$                                                                                    | 0.92     | 1.0  | 1.08   | V              |
|                                  | Delay to Output          |                                                                                                    |          | 100  |        | ns             |
|                                  | Gain                     |                                                                                                    | 2.85     | 3    | 3.15   | V/V            |
| <b>SOFT START</b>                |                          |                                                                                                    |          |      |        |                |
| $I_{SSC}$                        | SS Charge Current        |                                                                                                    | 14       | 20   | 26     | $\mu A$        |
| $I_{SSD}$                        | SS Discharge Current     | $V_{SS} = 0.6V$                                                                                    |          | 200  |        | $\mu A$        |
| $V_{SSSAT}$                      | SS Saturation Voltage    | DC = 0%                                                                                            |          |      | 0.6    | V              |
| $V_{SSCLAMP}$                    | SS Clamp Voltage         |                                                                                                    |          | 7    |        | V              |
| <b>LEADING EDGE BLANKING</b>     |                          |                                                                                                    |          |      |        |                |
|                                  | Internal Masking Time    |                                                                                                    |          | 100  |        | ns             |

## L4990 - L4990A

### ELECTRICAL CHARACTERISTICS (continued.)

| Symbol                         | Parameter                        | Test Condition                                                                           | Min. | Typ.     | Max. | Unit          |
|--------------------------------|----------------------------------|------------------------------------------------------------------------------------------|------|----------|------|---------------|
| <b>OUTPUT SECTION</b>          |                                  |                                                                                          |      |          |      |               |
| $V_{OL}$                       | Output Low Voltage               | $I_O = 250\text{mA}$                                                                     |      |          | 1.0  | V             |
| $V_{OH}$                       | Output High Voltage              | $I_O = 20\text{mA}; V_{CC} = 12\text{V}$                                                 | 10   | 10.5     |      | V             |
|                                |                                  | $I_O = 200\text{mA}; V_{CC} = 12\text{V}$                                                | 9    | 10       |      | V             |
| $V_{OUT\ CLAMP}$               | Output Clamp Voltage             | $I_O = 5\text{mA}; V_{CC} = 20\text{V}$                                                  |      | 13       |      | V             |
|                                | Collector Leakage                | $V_{CC} = 20\text{V}; V_C = 24\text{V}$                                                  |      | 100      | 200  | $\mu\text{A}$ |
|                                | Fall Time                        | $C_O = 1\text{nF}$<br>$C_O = 2.5\text{nF}$                                               |      | 20<br>35 | 60   | ns<br>ns      |
|                                | Rise Time                        | $C_O = 1\text{nF}$<br>$C_O = 2.5\text{nF}$                                               |      | 50<br>70 | 100  | ns<br>ns      |
|                                | UVLO Saturation                  | $V_{CC} = 0\text{V}$ to $V_{CCON}$ ; $I_{sink} = 10\text{mA}$                            |      |          | 1.0  | V             |
| <b>SUPPLY SECTION</b>          |                                  |                                                                                          |      |          |      |               |
| $V_{CCON}$                     | Startup voltage                  | <b>L4990</b>                                                                             | 15   | 16       | 17   | V             |
|                                |                                  | <b>L4990A</b>                                                                            | 7.8  | 8.4      | 9    | V             |
| $V_{CCOFF}$                    | Minimum Operating Voltage        | <b>L4990</b>                                                                             | 9    | 10       | 11   | V             |
|                                |                                  | <b>L4990A</b>                                                                            | 7    | 7.6      | 8.2  | v             |
| $V_{hys}$                      | Voltage After Turn-on Hysteresis | <b>L4990</b>                                                                             | 5.5  | 6        |      | V             |
|                                |                                  | <b>L4990A</b>                                                                            | 0.5  | 0.8      |      | v             |
| $I_S$                          | Start Up Current                 | Before Turn-on at:<br>$V_{CC} = V_{CCON} - 0.5\text{V}$                                  | 100  | 270      | 450  | $\mu\text{A}$ |
| $I_{op}$                       | Operating Current                | $C_T = 1\text{nF}$ , $R_T = 4.42\text{k}\Omega$ , $C_O = 1\text{nF}$                     |      | 12       | 18   | mA            |
| $I_q$                          | Quiescent Current                | (After turn on), $C_O = 0\text{nF}$<br>$C_T = 1\text{nF}$ , $R_T = 4.42\text{k}\Omega$ , |      | 7.0      | 10   | mA            |
| $I_{SH}$                       | Shutdown Current                 |                                                                                          | 100  | 270      | 450  | $\mu\text{A}$ |
| $V_Z$                          | Zener Voltage                    | $I_B = 20\text{mA}$                                                                      | 21   | 25       | 30   | V             |
| <b>SYNCHRONIZATION SECTION</b> |                                  |                                                                                          |      |          |      |               |
| <b>Master Operation</b>        |                                  |                                                                                          |      |          |      |               |
| $V_1$                          | Clock Amplitude                  | $I_{SOURCE} = 0.8\text{mA}$                                                              | 4    |          |      | V             |
| $I_1$                          | Clock Source Current             | $V_{clock} = 3.5\text{V}$                                                                |      | 7        |      | mA            |
| <b>Slave Operation</b>         |                                  |                                                                                          |      |          |      |               |
| $V_1$                          | Sync Pulse                       | Low Level                                                                                |      |          | 1    | V             |
|                                |                                  | High Level                                                                               | 3.5  |          |      | V             |
| $I_1$                          | Sync Pulse Current               | $V_{SYNC} = 3.5\text{V}$                                                                 | 0.8  |          |      | mA            |
| <b>OVER CURRENT PROTECTION</b> |                                  |                                                                                          |      |          |      |               |
| $V_t$                          | Fault Threshold Voltage          |                                                                                          | 1.1  | 1.2      | 1.3  | V             |
| <b>DISABLE SECTION</b>         |                                  |                                                                                          |      |          |      |               |
|                                | Shutdown threshold               |                                                                                          | 2.4  | 2.5      | 2.6  | V             |

### FUNCTIONAL DESCRIPTION

The I.C. contains a standard PWM current mode control section with improved performance with respect to the UC384X family. Enhanced features include start-up bias current reduced to  $< 270\mu\text{A}$  (typ), improved E/A performance (4MHz B/W, 1.3mA Source Current, high-slew rate) accurate 1MHz oscillator, and also reduced propagation delays in the critical path from Current Sense to Output.

### ADDITIONAL FEATURES

#### Soft Start (SS)

An external capacitor is charged by an internal constant current source ( $20\mu\text{A}$ ) to generate a SS signal which clamps the E/A output. The SS pin doubles as a Fault Reset Delay function as described below.

#### Current Limit / Reset Delay

An internal high-speed current limit comparator

referenced to 1.2V detects primary over-current conditions. On detection of an overcurrent fault the output is immediately shutdown and the fault is also latched. A Fault Reset Delay is implemented by discharging the external Soft Start (SS) timing capacitor before resetting the fault latch and initiating a softstart cycle.

In case of a continuous fault condition the SS capacitor is charged to 5V before being discharged again, to ensure that the fault frequency does not exceed the programmed soft start frequency.

### Duty Cycle Limit

A simple connection between the DC-LIM and the available Vref activates an internal T- FlipFlop limiting the DC to about 50%. If this pin is not connected or grounded, the limit of the duty cycle is extended to about 100%

### Duty Cycle Control

Duty Cycle DC is externally programmed by setting a voltage between 1V (0% DC) and 3V (100% DC) at the DC pin. The programmed voltage is compared with the oscillator  $C_T$  capacitor charging waveform to determine the maximum ON-time in each period. This function gives a fine control of DC.

If this pin is floating the maximum duty cycle depends on DC-LIM status.

### Synchronization

A SYNC pin eases Synchronization of the IC to the external world ( e.g. another IC working in

parallel or to TV/monitor sync signal).

In TV/monitor applications the timing components  $R_T$ ,  $C_T$  are set for a frequency lower than the minimum TV sync frequency. When the TV circuit has powered-up it takes over and the system frequency is that of the SYNC. Duty Cycle is controllable using the DC function.

In parallel operation of several IC's no Master/Slave designation is required as the higher frequency IC is automatically the master. Controllers to be synchronized have their SYNC pins tied together and each SYNC pin operates as a bidirectional circuit. The first IC to drive its SYNC pin is the master and it initiates a discharge of the  $C_T$  timing capacitor of every controller. The Sync input signal is edge-triggered and sets an internal "sync latch" which ensures full discharge of  $C_T$ .

### Disable Function

The DIS pin performs a logic level latched-shutdown function. When pulled above 2.5V it shuts down the complete IC with a standby current of  $<270\mu\text{A}$  (typ).

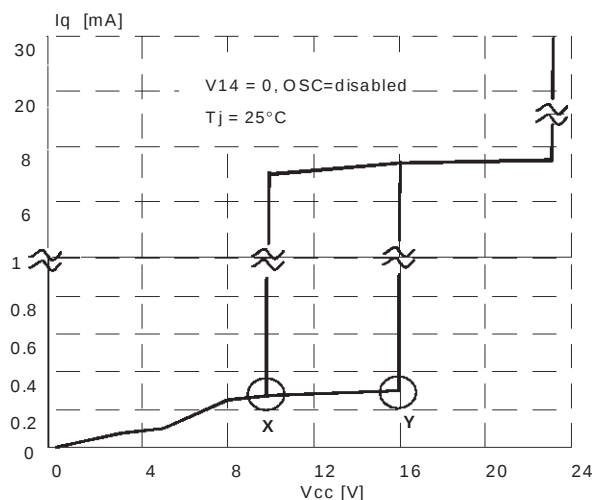
To reset the IC the  $V_{CC}$  pin must be pulled-down below the lower UVLO threshold (10V).

### Leading Edge Blanking (LEB)

An LEB interval of 100ns has been incorporated into the IC to blank out the current sense signal during the first 100ns from switch turn-on.

This provides noise immunity to turn-on spikes and reduces external RC filtering requirements on the current-sense signal.

**Figure 1. Quiescent current vs. input voltage.**  
(X = 7.6V and Y = 8.4V for L4990A)



**Figure 2. Quiescent current vs. input voltage**  
(after disable).

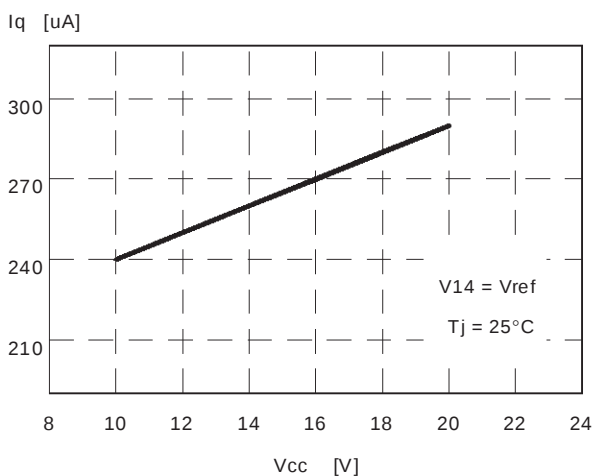


Figure 3. Quiescent current vs. input voltage.

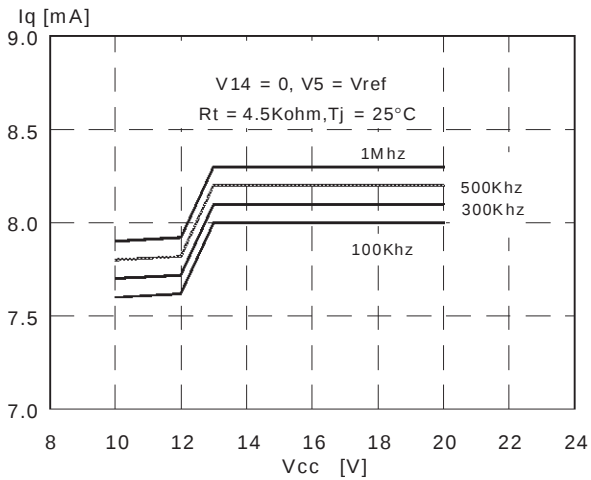


Figure 4. Quiescent current vs. input voltage and switching frequency.

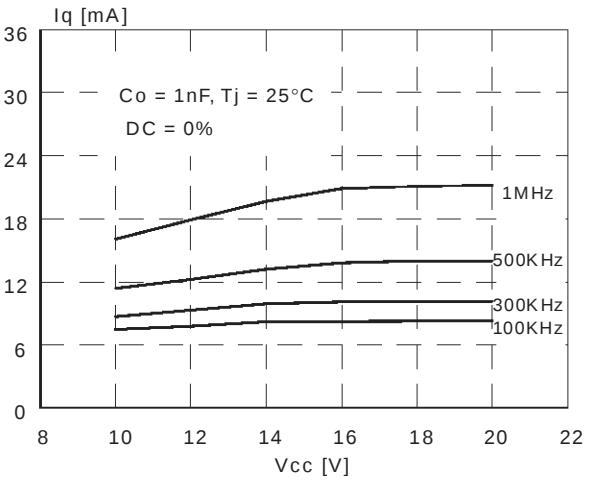


Figure 5. Quiescent current vs. input voltage and switching frequency.

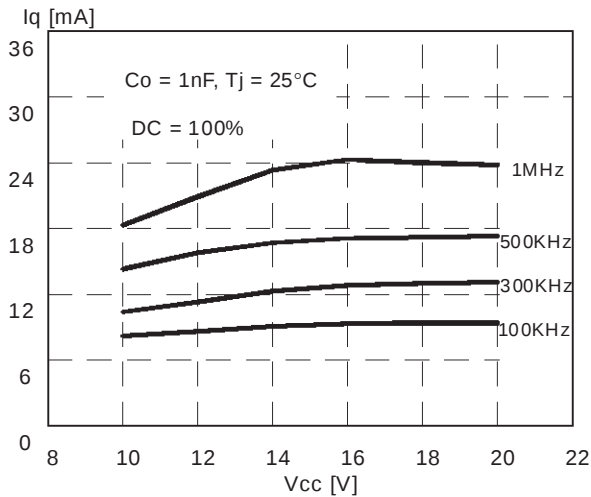


Figure 6. Reference voltage vs. load current.

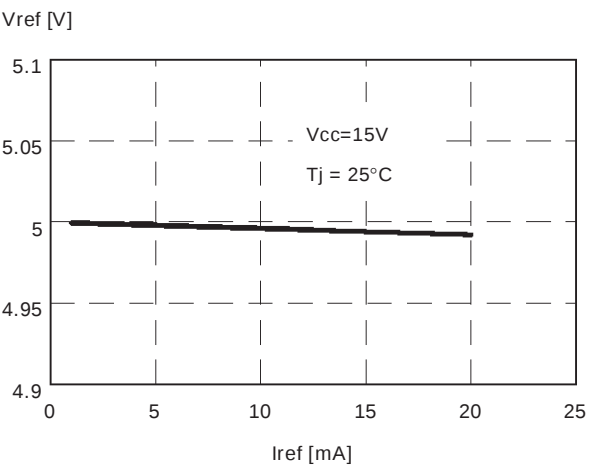


Figure 7. Vref vs. junction temperature.

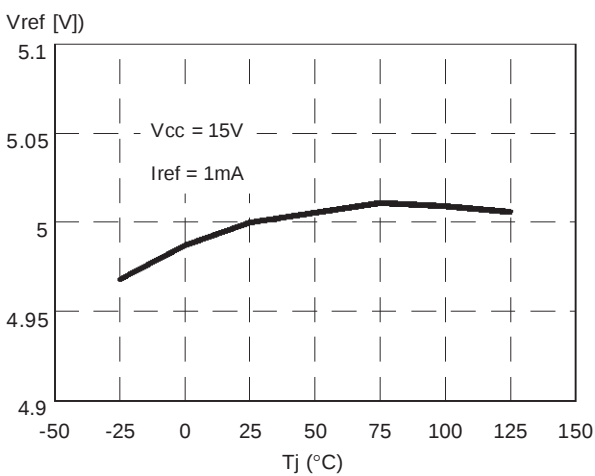


Figure 8. Vref vs. junction temperature.

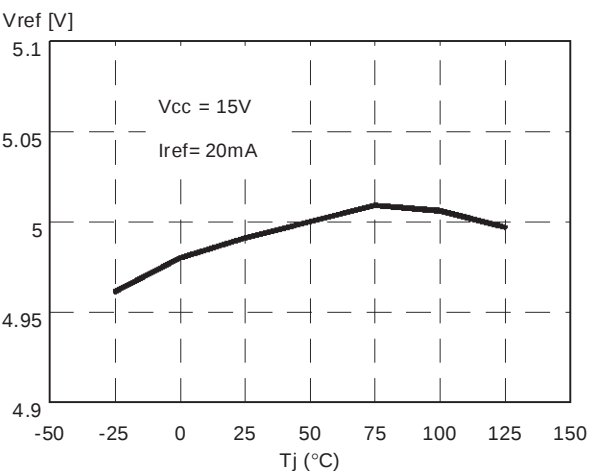


Figure 9. Vref SVRR vs. switching frequency.

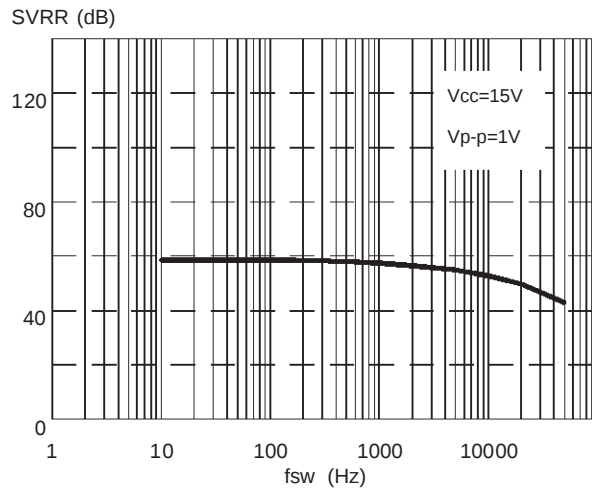


Figure 10. Output saturation.

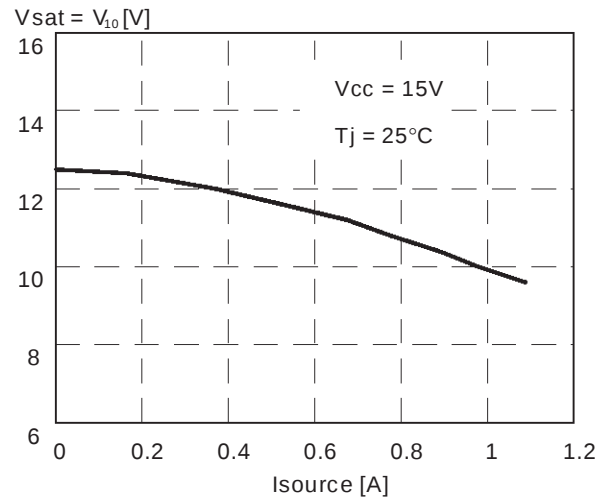


Figure 11. Output saturation.

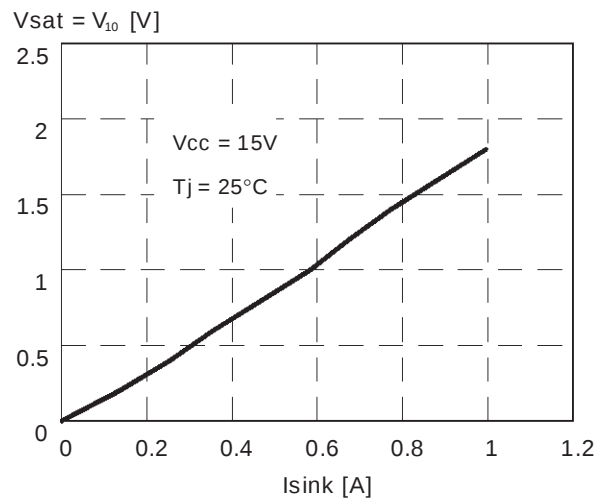


Figure 12. UVLO Saturation

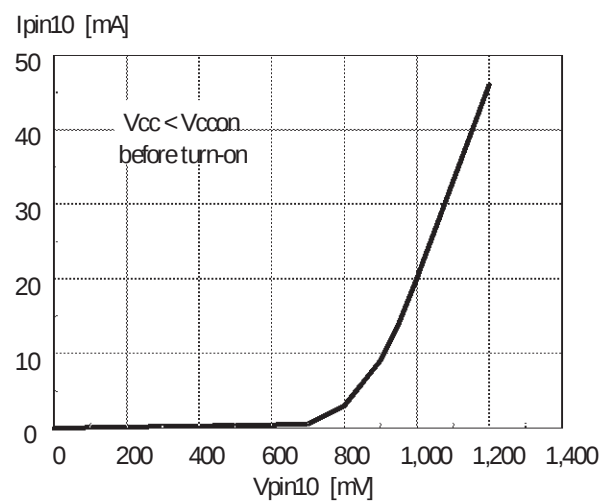


Figure 13. Timing resistor vs. switching frequency.

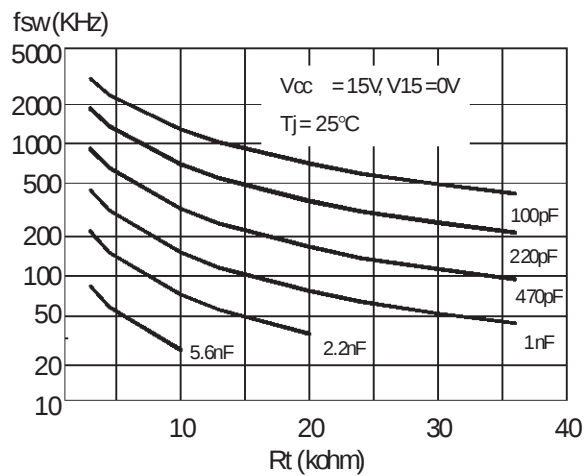


Figure 14. Switching frequency vs. temperature.

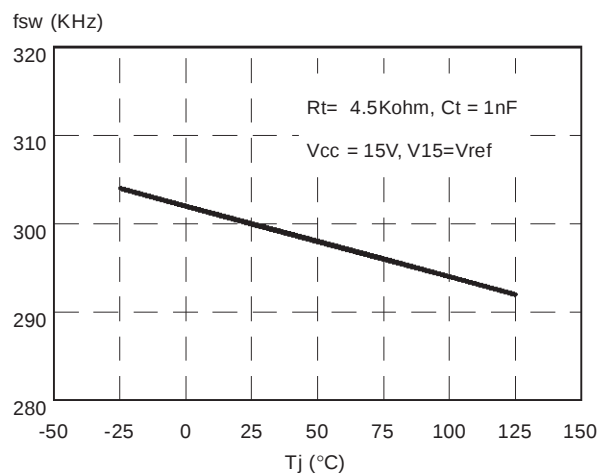


Figure 15. Switching frequency vs. temperature.

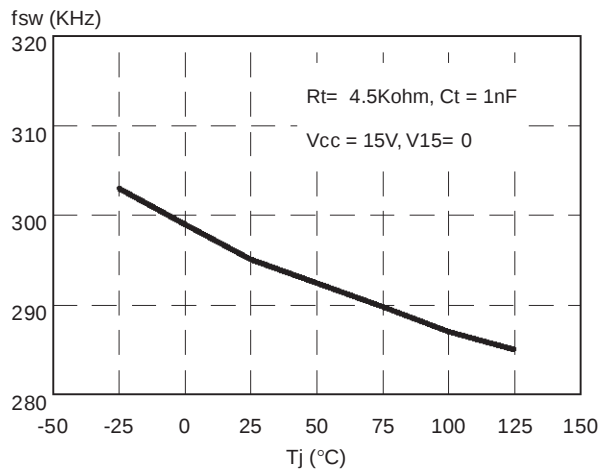


Figure 16. Dead time vs Ct.

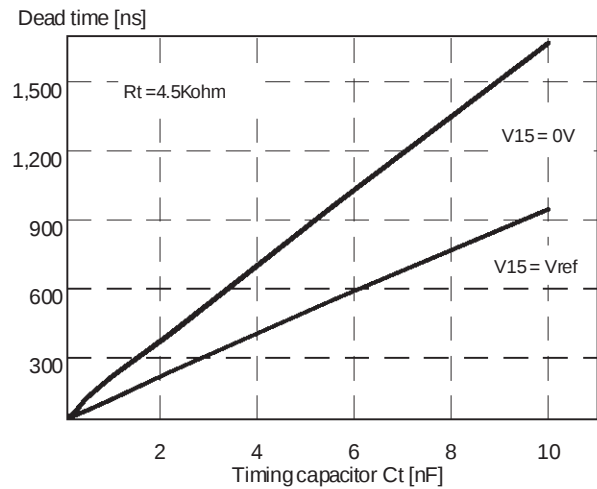


Figure 17. Maximum Duty Cycle vs Vpin3.

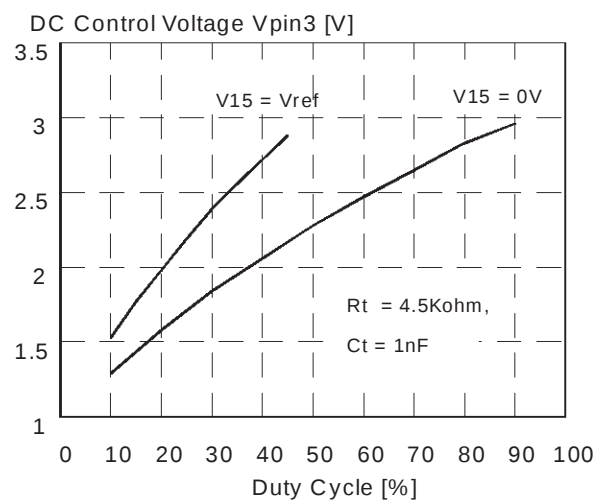


Figure 18. Delay to output vs junction temperature.

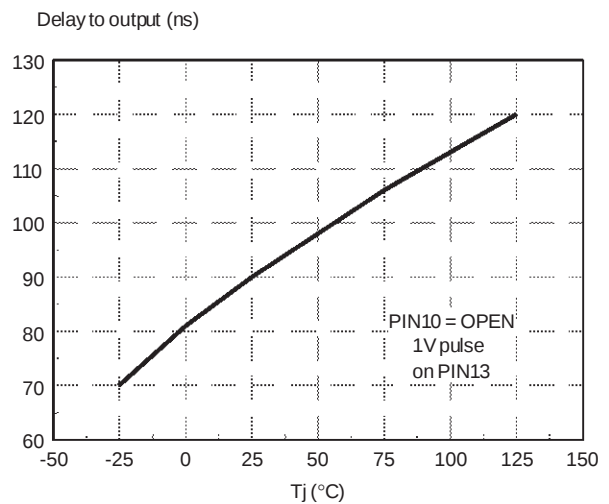
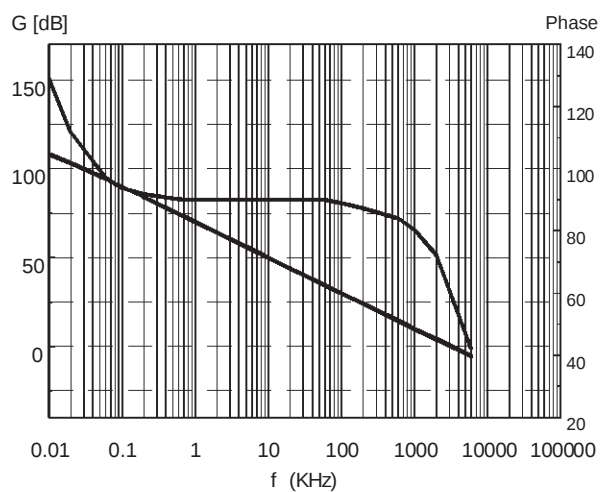


Figure 19. E/A frequency response.



## APPLICATION INFORMATION

## Detailed Pin Functions Description

**Pin 1. SYNC (In/Out Synchronization).** This function allows the IC's oscillator either to synchronize other controllers (master) or to be synchronized to an external frequency (slave).

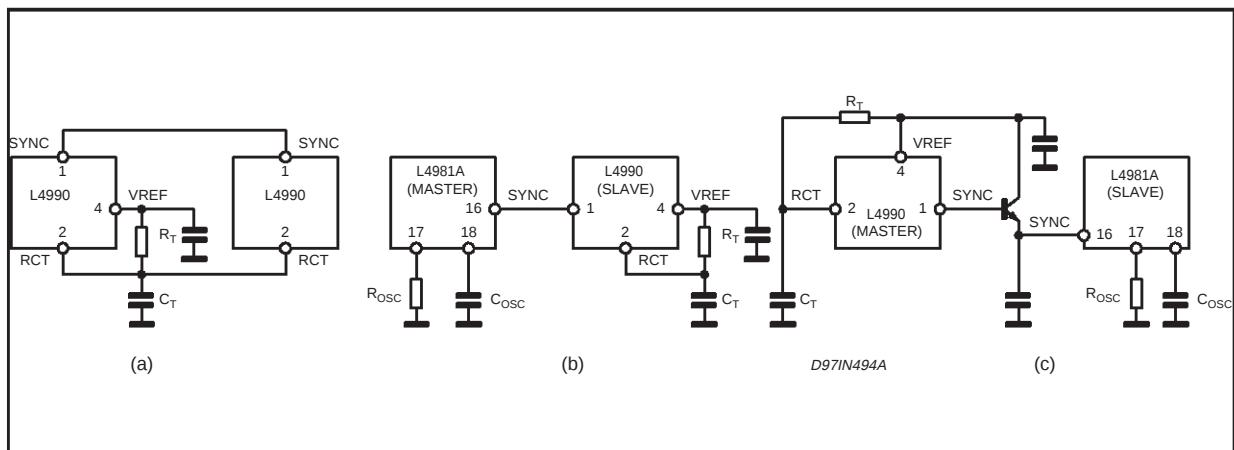
As a master, the pin delivers positive pulses during the ramp-down of the oscillator (see pin 2). In slave operation the circuit is edge triggered. Refer to fig. 21 to see how it works. When several IC

work in parallel no master-slave designation is needed because the fastest one becomes automatically the master.

During the ramp-up of the oscillator the pin is pulled low by a  $600\mu\text{A}$  generator. During the ramp-down, that is when the pulse is released, the  $600\mu\text{A}$  pull-down is disconnected. The pin becomes a generator whose source capability is typically  $7\text{mA}$  (with a voltage still higher than  $3.5\text{V}$ ).

In fig. 20, some practical examples of synchronizing the L4990 are given.

**Figure 20. Synchronizing the L4990.**

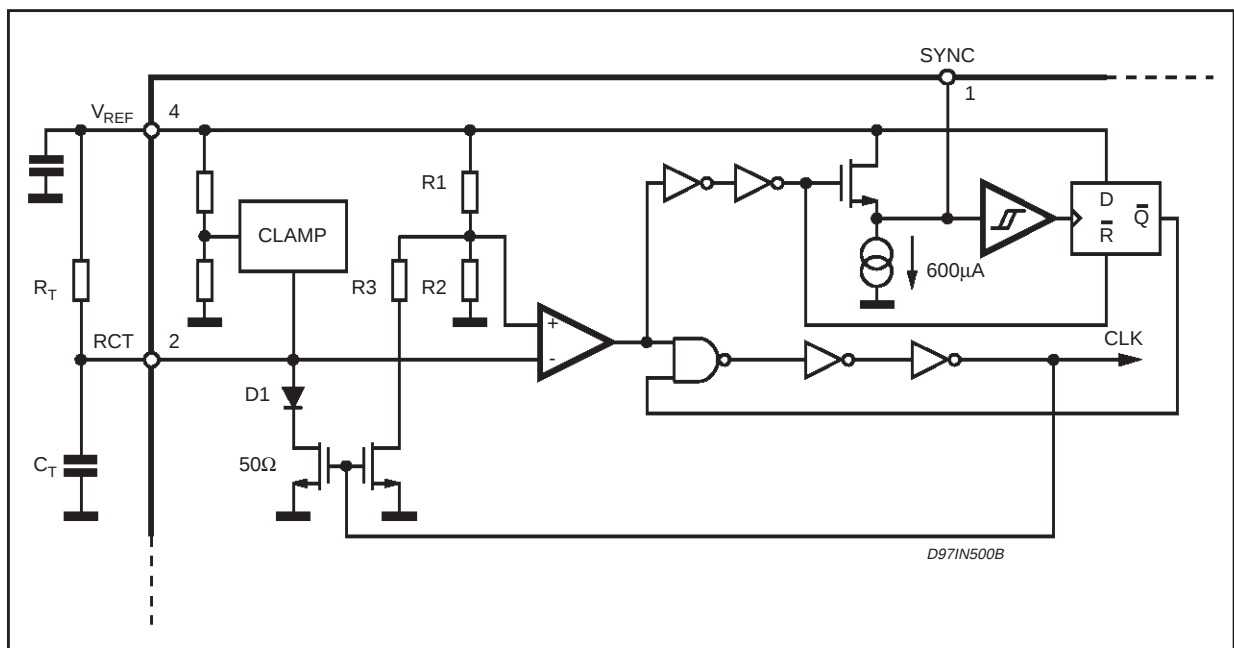


**Pin 2. RCT (Oscillator).** A resistor ( $R_T$ ) and a capacitor ( $C_T$ ), connected as shown in fig. 21 set the operating frequency  $f_{OSC}$  of the oscillator.

$C_T$  is charged through  $R_T$  until its voltage reaches

$3\text{V}$ , then is quickly internally discharged. As the voltage has dropped to  $1\text{V}$  it starts being charged again

**Figure 21. Oscillator and synchronization internal schematic.**



The frequency can be established with the aid of fig. 13 diagrams or considering the approximate relationship:

$$f_{osc} \cong \frac{1}{C_T \cdot (0.693 \cdot R_T + K_T)} \quad (1)$$

where  $K_T$  is defined as:

$$K_T = \begin{cases} 90, & V_{15} = V_{REF} \\ 160 & V_{15} = GND/OPEN \end{cases} \quad (2)$$

and is linked to the duration of the falling edge of the sawtooth:

$$T_d \cong 30 \cdot 10^{-9} + K_T \cdot C_T \quad (3)$$

$T_d$  is also the duration of the sync pulses delivered at pin 1 and defines the upper extreme of the duty cycle range,  $D_x$  (see pin 15 for  $D_x$  definition and calculation).

In case  $V_{15}$  is connected to  $V_{REF}$ , however, the switching frequency of the system will be as high as half  $f_{osc}$ .

If the IC is to be synchronized to an external oscillator,  $R_T$  and  $C_T$  should be selected for a  $f_{osc}$  lower than the master frequency in any condition (typically, 10-20% ), depending on the tolerance of  $R_T$  and  $C_T$  itself.

**Pin 3.** DC (Duty Cycle Control). By biasing this pin with a voltage between 1 and 3 V it is possible to set the maximum duty cycle between 0 and the upper extreme  $D_x$  (see pin 15).

If  $D_{max}$  is the desired maximum duty cycle, the voltage  $V_3$  to be applied to pin 3 is:

$$V_3 = 5 - 2^{(2-D_{max})} \quad (4)$$

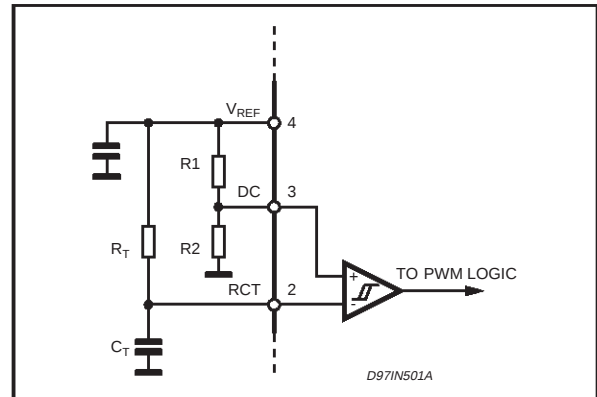
$D_{max}$  is determined by internal comparison between  $V_3$  and the oscillator ramp (see fig. 22), thus in case the device is synchronized to an external frequency  $f_{ext}$  (and therefore the oscillator amplitude is reduced), (4) changes into:

$$V_3 = 5 - 4 \cdot \exp\left(-\frac{D_{max}}{R_T \cdot C_T \cdot f_{ext}}\right) \quad (5)$$

A voltage below 1V will inhibit the driver output stage. This could be used for a not-latched device disable, for example in case of overvoltage protection (see application ideas).

If no limitation on the maximum duty cycle is required (i.e.  $D_{MAX} = D_x$ ), the pin has to be left floating. An internal pull-up holds the voltage above 3V. Should the pin pick up noise (e.g. during ESD tests), it can be connected to  $V_{REF}$  through a 4.7kΩ resistor.

Figure 22. Duty cycle control.



**Pin 4.**  $V_{REF}$  (Reference Voltage). An internal generator furnishes an accurate voltage reference ( $5V \pm 1.5\%$ ) that can be used to supply an external circuit (consider some ten mA).

A small film capacitor (1  $\mu F$  typ.), connected between this pin and SGND, is recommended to prevent switching noise from affecting the reference. Before device turn-on, this pin has a sink current capability of 0.5mA.

**Pin 5.** VFB (Error Amplifier Inverting Input). The feedback signal is applied to this pin and is compared to the E/A internal reference (2.5V). The E/A output generates the control voltage which fixes the duty cycle.

The E/A features high gain-bandwidth product, which allows to broaden the bandwidth of the overall control loop, high slew-rate and current capability, which improves its large signal behavior. Usually the compensation network, which stabilizes the overall control loop, is connected between this pin and COMP (pin 6).

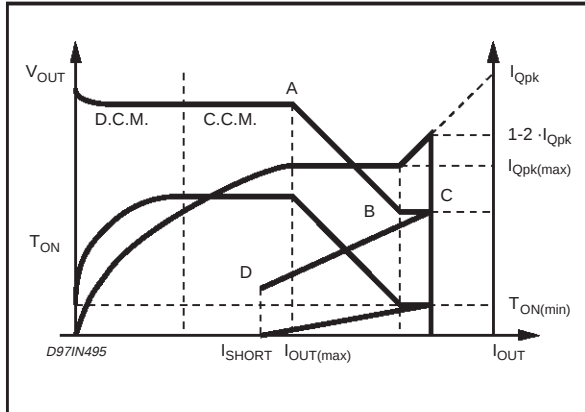
**Pin 6.** COMP (Error Amplifier Output). Usually, this pin is used for frequency compensation and the relevant network is connected between this pin and VFB (pin 5). Compensation networks towards ground are not possible since the L4990 E/A is a voltage mode amplifier (low output impedance). See application ideas for some example of compensation techniques.

**Pin 7.** SS (Soft-Start). At device start-up, a capacitor ( $C_{ss}$ ) connected between this pin and SGND (pin 12) is charged by an internal current generator, ISSC, up to about 7V. During this ramp, the E/A output is clamped by the voltage across  $C_{ss}$  itself and allowed to rise linearly, starting from zero, up to the steady-state value imposed by the control loop. The maximum time interval during which the E/A is clamped, referred to as soft-start time, is approximately:

$$T_{SS} \cong \frac{3 \cdot R_{sense} \cdot I_{Qpk}}{I_{SSC}} \cdot C_{SS} \quad (6)$$

where  $R_{sense}$  is the current sense resistor (see pin 13) and  $I_{Qpk}$  is the switch peak current (flowing through  $R_{sense}$ ), which depends on the output load. Usually,  $C_{SS}$  is selected for a  $T_{SS}$  in the order of milliseconds.

**Figure 23. Regulation characteristic and related quantities**



As mentioned before, the soft-start intervenes also in case of severe overload or short circuit on the output. Referring to fig. 23, pulse-by-pulse current limitation is somehow effective as long as the ON-time of the power switch can be reduced (from A to B). After the minimum ON-time is reached (from B onwards) the current is out of control.

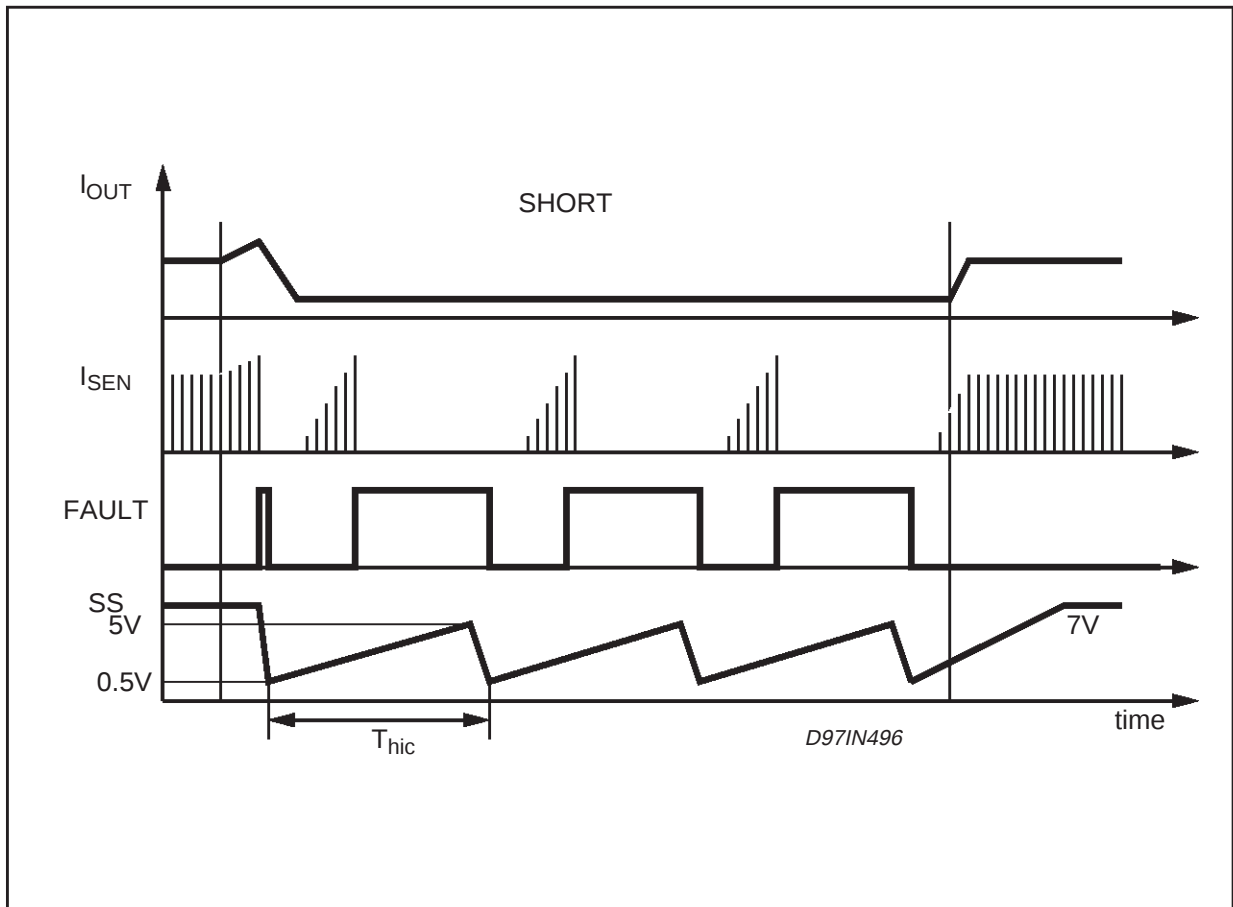
To prevent this risk, a comparator trips an over-current handling procedure, named 'hiccup' mode operation, when a voltage above 1.2V (point C) is detected on current sense input (ISEN, pin 13). Basically, the IC is turned off and then soft-started as long as the fault condition is detected. As a result, the operating point is moved abruptly to D, creating a foldback effect. Fig. 24 illustrates the operation.

The oscillation frequency appearing on the soft-start capacitor in case of permanent fault, referred to as 'hiccup' period, is approximately given by:

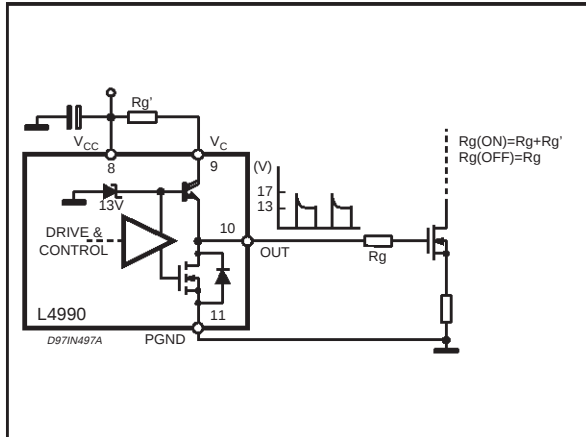
$$T_{hic} \cong 4.5 \cdot \left( \frac{1}{I_{SSC}} + \frac{1}{I_{SSD}} \right) \cdot C_{SS} \quad (7)$$

Since the system tries restarting each hiccup cycle, there is not any latchoff risk.

**Figure 24. Hiccup mode operation.**



**Figure 25. Turn-on and turn-off speeds adjustment**



"Hiccup" keeps the system in control in case of short circuits but does not eliminate power components overstress during pulse-by-pulse limitation (from A to C). Other external protection circuits are needed if a better control of overloads is required.

**Pin 8.** VCC (Controller Supply). This pin supplies the signal part of the IC. The device is enabled as VCC voltage exceeds the start threshold and works as long as the voltage is above the UVLO threshold. Otherwise the device is shut down and the current consumption is extremely low.

An internal Zener limits the voltage on VCC to 25V. Below this value the IC current consumption is low but increases considerably if this limit is exceeded.

A small film capacitor between this pin and SGND (pin 12), placed as close as possible to the IC, is recommended to filter high frequency noise.

**Pin 9.** VC (Supply of the Power Stage). It supplies the driver of the external switch and therefore absorbs a pulsed current. Thus it is recommended to place a buffer capacitor (towards PGND, pin 11, as close as possible to the IC) able to sustain these current pulses and in order to avoid them inducing disturbances.

This pin can be connected to the buffer capacitor directly or through a resistor, as shown in fig. 25, to control separately the turn-on and turn-off speed of the external switch, typically a Power-MOS. At turn-on the gate resistance is  $R_g + R_g'$  and turn-off is  $R_g$  only.

**Pin 10.** OUT (Driver Output). This pin is the output of the driver stage of the external power switch. Usually, this will be a PowerMOS, although the driver is powerful enough to drive BJT's (1.6A source, 2A sink, peak).

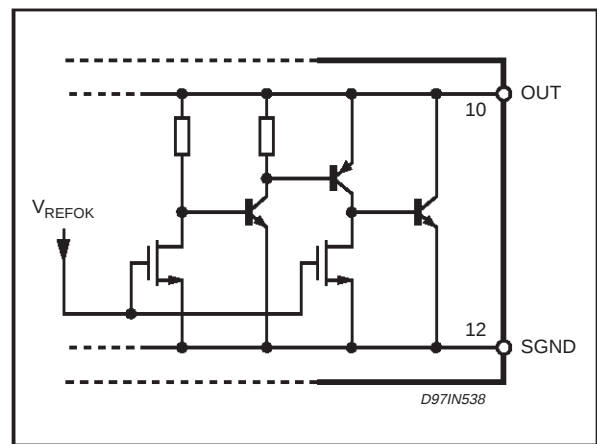
The driver is made up of a totem pole with a high-side NPN Darlington and a low-side VDMOS, and

delivers a voltage internally clamped, as shown in fig. 25. Thus it is possible to supply the driver (pin 9) with higher voltages without any problem of damage for the gate oxide of the external MOS, but, of course, the power dissipation on the IC will increase.

In UVLO conditions an internal circuit (shown in fig.26) holds the pin low in order to ensure that the external MOS cannot be turned on accidentally. The peculiarity of this circuit is its ability to maintain the same sink capability (typically, 20mA @ 1V) from  $V_{CC} = 0V$  up to the start-up threshold. When the threshold is exceeded and the L4990 starts operating,  $V_{REFOK}$  is pulled high (refer to fig. 26) and the circuit is disabled.

It is then possible to omit the "bleeder" resistor (connected between the gate and the source of the MOS) ordinarily used to prevent undesired switching-on of the external MOS because of some leakage current.

**Figure 26. Pull-Down of the output in UVLO.**



**Pin 11.** PGND (Power Ground). The current loop during the discharge of the gate of the external MOS is closed through this pin. This loop should be as short as possible to reduce EMI and run separately from signal currents return.

**Pin 12.** SGND (Signal Ground). This ground references the control circuitry of the IC, so all the ground connections of the external parts related to control functions must lead to this pin. In laying out the PCB, care must be taken in preventing switched high currents from flowing through the SGND path.

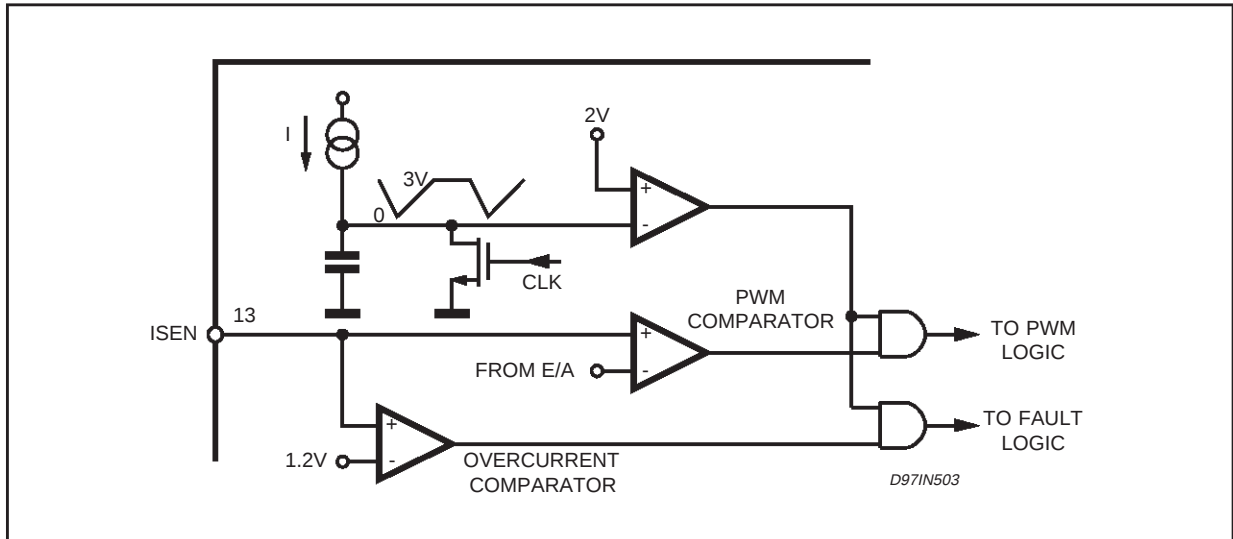
**Pin 13.** ISEN (Current Sense). This pin is to be connected to the "hot" lead of the current sense resistor  $R_{sense}$  (being the other one grounded), to get a voltage ramp which is an image of the current of the switch, ( $I_Q$ ). When this voltage is equal to:

$$V_{13pk} = I_{Qpk} \cdot R_{sense} = \frac{(V_{COMP} - 1.4)}{3} \quad (8)$$

the conduction of the switch is terminated.

To increase the noise immunity, a "Leading Edge Blanking" of about 100ns is internally realized as shown in fig. 27. Because of that, the smoothing RC filter between this pin and  $R_{sense}$  could be removed or, at least, considerably reduced.

Figure 27. Internal LEB

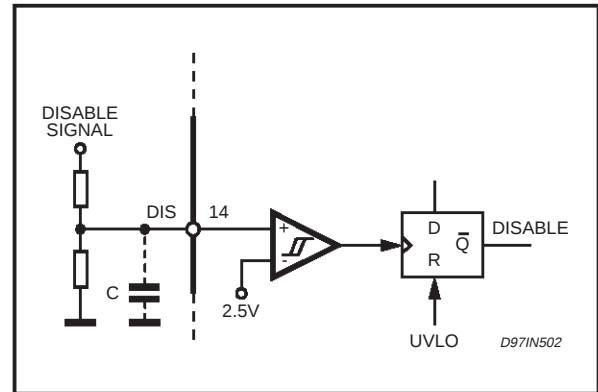


**Pin 14. DIS (Device Disable).** When the voltage on pin 14 rises above 2.5V the IC is shut down and it is necessary to pull VCC (IC supply voltage, pin 8) below the UVLO threshold to allow the device to restart. When disabled, the current consumption of the IC is as low as before start-up.

The pin can be driven by an external logic signal in case of power management, as shown in fig. 28. It is also possible to realize an overvoltage protection, as shown in the section "Application Ideas".

If used, bypass this pin to ground with a filter capacitor to avoid spurious activation due to noise spikes. If not, it is advisable to connect the pin to SGND, even though it might be left floating.

Figure 28. Disable (Latched)



**Pin 15. DC-LIM (Maximum Duty Cycle Limit).** The upper extreme,  $D_x$ , of the duty cycle range depends on the voltage applied to this pin. Approximately,

$$D_x \cong \frac{R_T}{R_T + 230} \quad (9)$$

if DC-LIM is grounded or left floating. Instead, connecting DC-LIM to VREF (half duty cycle option),  $D_x$  will be set approximately to:

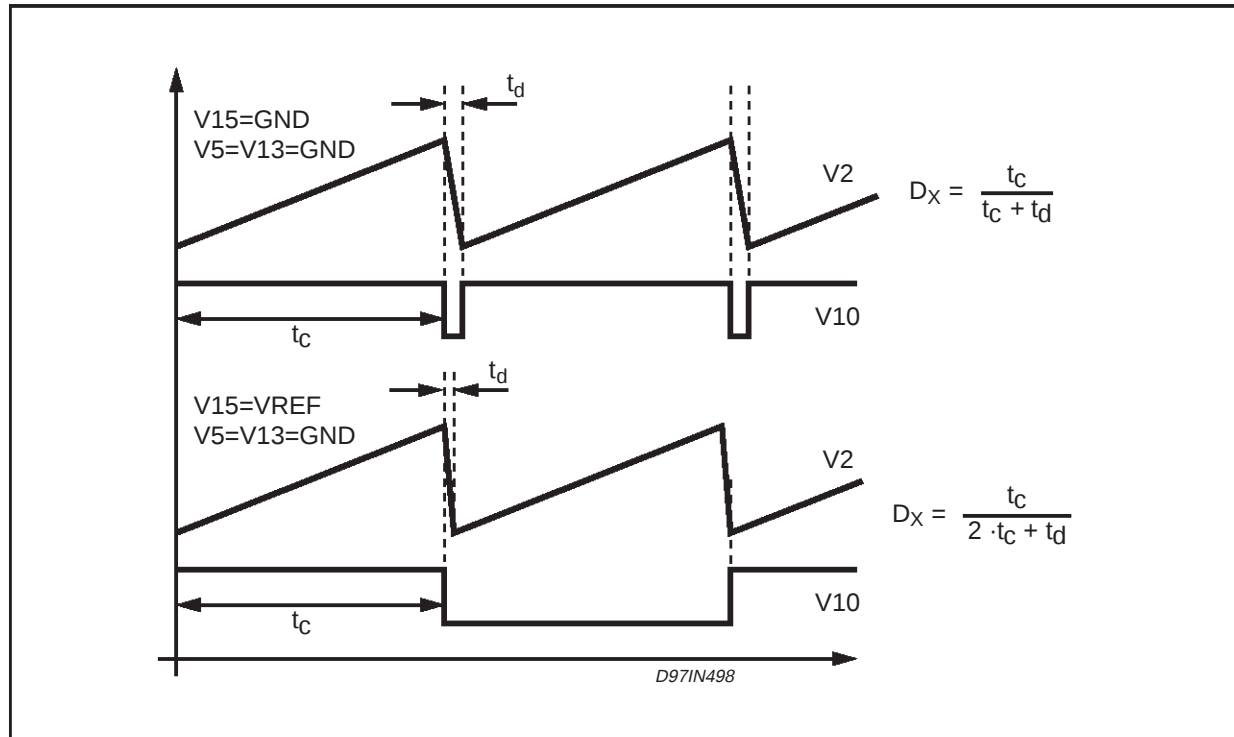
$$D_x \cong \frac{R_T}{2 \cdot R_T + 260} \quad (10)$$

and the output switching frequency will be halved with respect to the oscillator one because an internal T flip-flop (see block diagram, fig. 1) is activated. Fig. 29 shows the operation.

The half duty cycle option speeds up the discharge of the timing capacitor  $C_T$  (in order to get duty cycles as close as possible to 50%) so the oscillator frequency - with the same  $R_T$  and  $C_T$  - will be slightly higher.

The halving of frequency can be used to reduce losses at light load in all those systems that must comply with requirements regarding energy consumption (e.g. monitor displays).

Figure 29. Half duty cycle option.



### DEMONSTRATION BOARD

To evaluate the device performance, a demonstration board has been realized. Despite its simplicity, it exploits most of the features of the L4990.

The board embodies an application based on the following specification of universal mains AC-DC adapter:

- Input voltage range: 85-270 Vac (50/60 Hz)
- Output voltage: 15 V
- Output current: 0.5 to 2A
- Output voltage ripple : 300 mV (max.)
- Load regulation:  $\pm 5\%$  (0.5 to 2 A load change)
- Target efficiency @  $I_{out} = 2\text{ A}$  ; 80% over the input voltage full range

Some preliminary decisions, concerning topology, operating mode, switching frequency, maximum duty cycle allowed and control technique, have been made.

As for topology, at this power level and output voltage, flyback is the most advantageous one, mainly because of its simplicity, which means low parts count, low cost and inherent high efficiency.

A peculiar design choice aiming at optimizing the overall system concerns the operating mode: the converter will work in continuous current mode at low input voltages, when input current is greater, and in discontinuous mode at higher input volt-

ages. Numerous benefits originate from that.

Compared to discontinuous current mode, continuous operation involves lower peak currents (typ. -40%) at the same throughput power. This implies less stress for all power components.

The transformer inductance is higher and, therefore, a smaller air gap is required for a given core: this increases primary-to-secondary coupling and, as a consequence, reduces leakage inductance and improves energy transfer. Both efficiency and load regulation will take advantage of that.

Another point in favor is a reduction of the minimum output power that the system is able to deliver keeping the output well regulated.

Few components are required in addition for slope compensation.

Actually, continuous mode flyback suffers also from a poor dynamic behavior during load transients because of the narrow bandwidth of the control loop due to stability problems. However, great dynamic performance is not required to AC-DC adapters, so this problem is of no concern.

The boundary between the two operating modes has been set at about 150 Vac (@  $I_{out}=2\text{A}$ ).

The selection of the switching frequency is a matter of trade-off between achieving a small transformer size and high efficiency. 200 kHz seems to be a good compromise.

In this application, the wide input voltage range requires a large duty cycle sweep. The higher is the maximum duty cycle, the larger is the operat-

ing conditions range, in terms of input voltage and output current, that the converter is able to cover but, on the other hand, the higher is the peak current on the secondary side.

As to this point, the L4990 turns out to be particularly useful since it allows to set any maximum duty cycle greater (and lower) than 50% with very good precision. In the present case, a maximum duty cycle of 60% for steady state operation has been selected and an extra 5% is allowed to take transients into account.

Since it is not requested a very tight tolerance on the output, the feedback employs a primary side voltage sensing technique to reduce cost and complexity of the circuit. The same technique has been used to protect against output overvoltages.

The electric schematic is shown in fig. 30. The PCB layout is shown in figg. 31 and 32. Table 1 and 2 summarize typical system performance, while table 3 lists the relevant bill of material, where details are given only for critical components and/or where useful.

**Warning:** the NTC for inrush current limitation is not assembled, thus use caution when connecting the demo board to the mains directly. The use of a variac or an isolation transformer is recommended.

**Table 1. System efficiency.**

| $V_{in}$ (Vac) | $I_{out} = 1A$ |          | $I_{out} = 2A$ |          |
|----------------|----------------|----------|----------------|----------|
|                | $V_{out}$ (V)  | Effic. % | $V_{out}$ (V)  | Effic. % |
| 85             | 14.93          | 83.7     | 14.53          | 84.3     |
| 110            | 14.95          | 82.5     | 14.55          | 84.9     |
| 220            | 14.95          | 81.4     | 14.57          | 85.2     |
| 270            | 14.96          | 76       | 14.59          | 81.6     |

**Table 2. System performance.**

|                                             |                                                |                |
|---------------------------------------------|------------------------------------------------|----------------|
| Line regulation                             | $V_{in} = 85$ to $270$ Vac<br>$I_{out} = 0.5A$ | 30mV           |
| Load regulation<br>$I_{out} = 0.5A$ to $2A$ | $V_{in} = 85$ Vac<br>$V_{in} = 270$ Vac        | 0.95V<br>0.90V |
| Maximum effic.                              | $V_{in} = 190$ Vac<br>$I_{out} = 2A$           | 86.2%          |
| Output ripple                               | $V_{in} = 85$ to $270$ Vac<br>$I_{out} = 2A$   | < 200mV        |
| Minimum load                                | $V_{in} = 270$ Vac<br>$V_{out} < 20V$          | 150mA          |
| Transition Volt.                            | From C.C.M to D.C.M<br>$I_{out} = 2A$          | 160V           |

**Figure 30. AC-DC adaptor electric schematic**

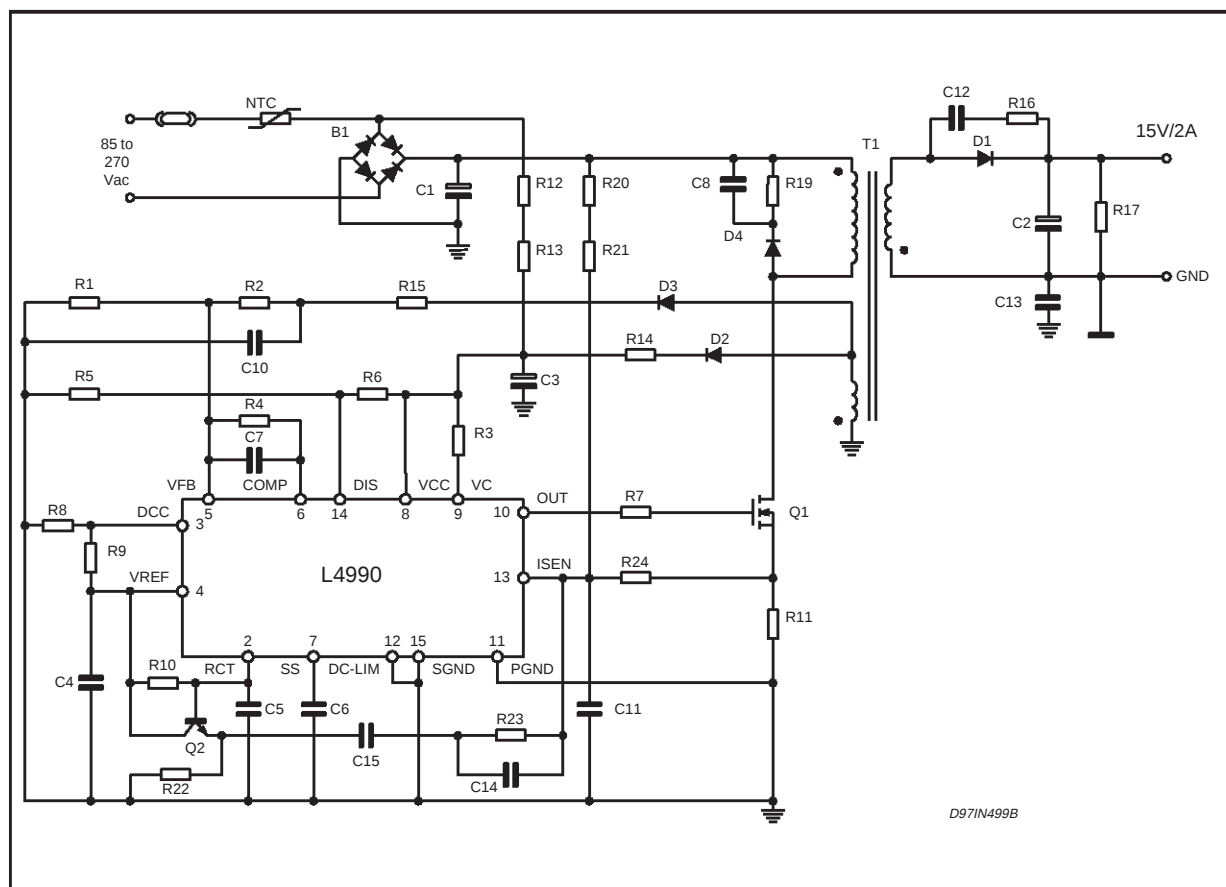


Table 3. Components List of the Fig. 30 AC-DC adaptor electric schematic.

| Component   | Reference | Value         | Description                                                                                                                                                                                                                                 |
|-------------|-----------|---------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Resistors   | R1        | 1.6k $\Omega$ | 2%, 1/8W                                                                                                                                                                                                                                    |
|             | R2        | 9.1k $\Omega$ | 2%, 1/8W                                                                                                                                                                                                                                    |
|             | R3, R14   | 10 $\Omega$   | 5%, 1/8W                                                                                                                                                                                                                                    |
|             | R4        | 360k $\Omega$ | 2%, 1/8W                                                                                                                                                                                                                                    |
|             | R5        | 27k $\Omega$  | 2%, 1/8W                                                                                                                                                                                                                                    |
|             | R6        | 200k $\Omega$ | 2%, 1/8W                                                                                                                                                                                                                                    |
|             | R7        | 4.7 $\Omega$  | 2%, 1/8W                                                                                                                                                                                                                                    |
|             | R8, R9    | 4.7k $\Omega$ | 2%, 1/8W                                                                                                                                                                                                                                    |
|             | R10       | 5.6k $\Omega$ | 2%, 1/8W                                                                                                                                                                                                                                    |
|             | R11       | 1 $\Omega$    | 2%, 1/2W, metallic film (low inductance)                                                                                                                                                                                                    |
|             | R12, R13  | 24k $\Omega$  | 2%, 1/2W                                                                                                                                                                                                                                    |
|             | R15       | 330 $\Omega$  | 5%, 1/8W                                                                                                                                                                                                                                    |
|             | R16       | -             | Not used                                                                                                                                                                                                                                    |
|             | R17       | 390 $\Omega$  | 5%, 1W, 2 paralleled resistors (not used)                                                                                                                                                                                                   |
|             | R19       | 100k $\Omega$ | 5%, 1W                                                                                                                                                                                                                                      |
|             | R20, R21  | 470k $\Omega$ | 2%, 1/8W                                                                                                                                                                                                                                    |
|             | R22       | 200 $\Omega$  | 5%, 1/8W                                                                                                                                                                                                                                    |
|             | R23       | 2k $\Omega$   | 2%, 1/8W                                                                                                                                                                                                                                    |
|             | R24       | 1k $\Omega$   | 5%, 1/8W                                                                                                                                                                                                                                    |
| Capacitors  | C1        | 100 $\mu$ F   | 400V, NCC-SMH or equiv.                                                                                                                                                                                                                     |
|             | C2        | 330 $\mu$ F   | 25V, NCC-LXF or equiv., 3 paralleled capacitors                                                                                                                                                                                             |
|             | C3        | 47 $\mu$ F    | 25V, electrolytic                                                                                                                                                                                                                           |
|             | C4        | 1 $\mu$ F     | 10V, electrolytic                                                                                                                                                                                                                           |
|             | C5        | 1nF           | J precision                                                                                                                                                                                                                                 |
|             | C6, C15   | 10nF          |                                                                                                                                                                                                                                             |
|             | C7, C14   | 330pF         |                                                                                                                                                                                                                                             |
|             | C8        | 330pF         | 160V, polypropylene                                                                                                                                                                                                                         |
|             | C9        | 100nF         |                                                                                                                                                                                                                                             |
|             | C10       | 220nF         |                                                                                                                                                                                                                                             |
|             | C11       | 100pF         | ceramic                                                                                                                                                                                                                                     |
|             | C12       | -             | Not used                                                                                                                                                                                                                                    |
|             | C13       | 4.7nF         | 630V                                                                                                                                                                                                                                        |
| Transformer | T1        | 380 $\mu$ H   | Core: EFD25, Philips, 3F3 ferrite (or equivalent)<br>Primary: 46 T, litz wire 20 x 0.1, interleaved assembly<br>Secondary: 6 T, 4 paralleled litz wire 20 x 0.1<br>Auxiliary: 7 T (evenly spaced), $\varnothing$ 0.2 mm GAP $\approx$ 0.7mm |
| Transistors | Q1        | STP5NA80      | ST, TO220 package                                                                                                                                                                                                                           |
|             | Q2        | 2N2222        | ST (or equivalent)                                                                                                                                                                                                                          |
| Diodes      | B1        | DF04M         | GI (or equivalent)                                                                                                                                                                                                                          |
|             | D1        | STPS20100CT   | ST, Schottky, TO220 package                                                                                                                                                                                                                 |
|             | D2, D3    | 1N4148        | ST (or equivalent)                                                                                                                                                                                                                          |
|             | D4        | BYT11-600     | ST, F126 package                                                                                                                                                                                                                            |
| Fuse        | Fuse      | T2A250V       | ELU (or equivalent)                                                                                                                                                                                                                         |
| NTC         | NTC       | -             | Not used (see warning)                                                                                                                                                                                                                      |

Figure 31. AC-DC adaptor PCB layout (1.25 : 1 scale) - Component Side.

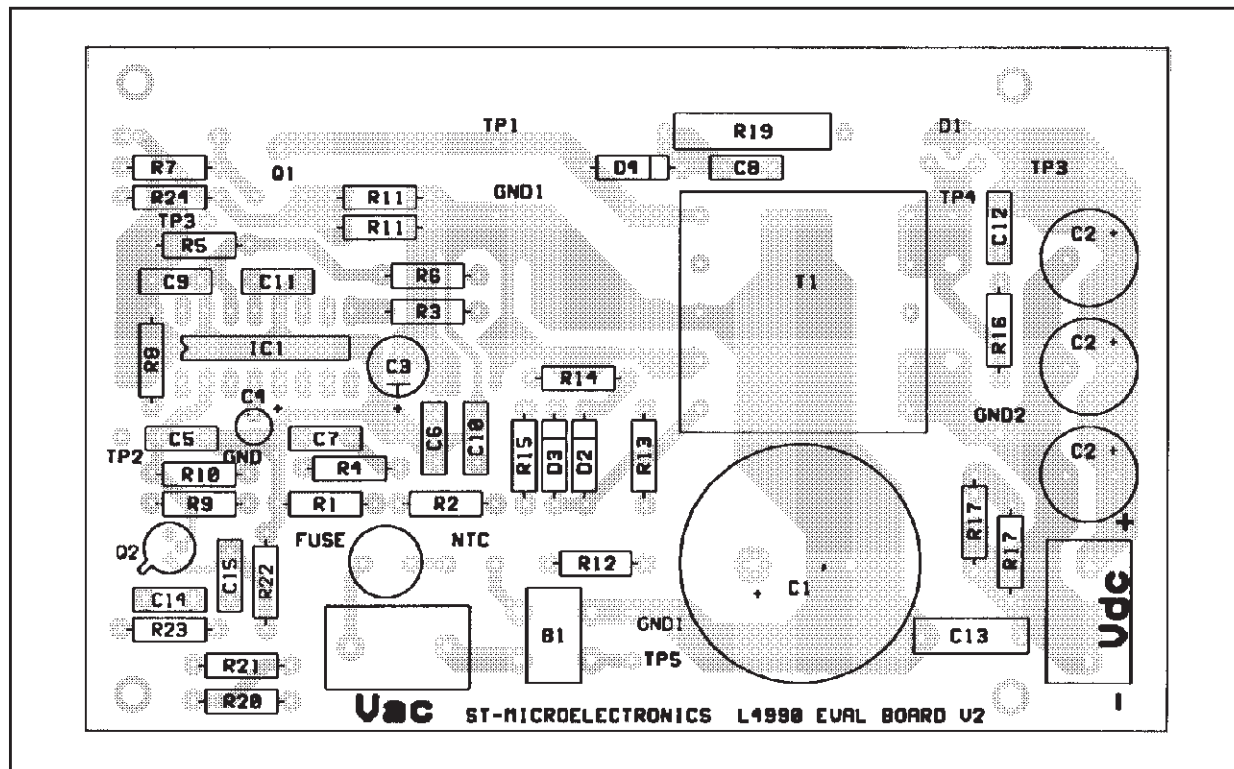
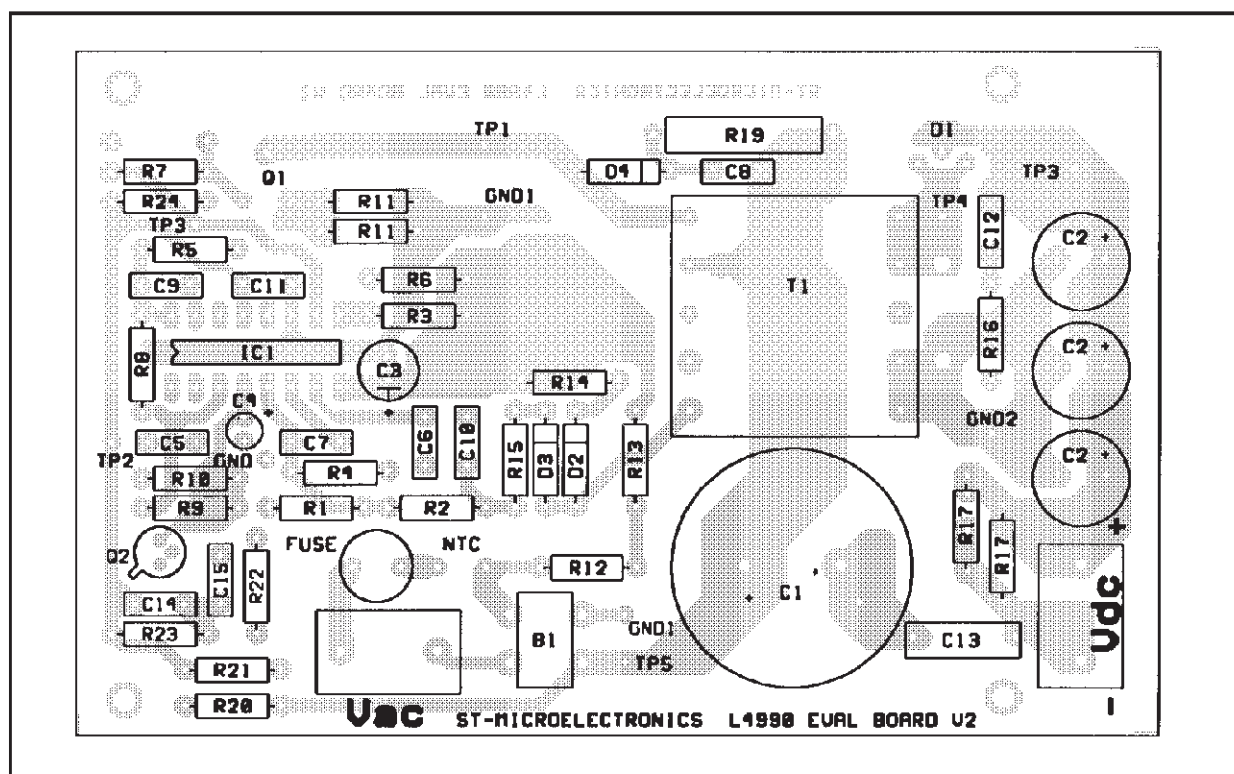


Figure 32. AC-DC adaptor PCB layout (1.25 : 1 scale) - Back Side.



**Layout hints.** Generally speaking a proper circuitboard layout is vital for correct operation but is not an easy task. Careful component placing, correct traces routing, appropriate traces widths and, in case of high voltages, compliance with isolation distances are the major issues. The L4990 eases this task by putting two pins at disposal for separate current returns of bias (SGND) and switch drive currents (PGND). The matter is complex and only few important points will be here reminded.

- 1) All current returns (signal ground, power ground, shielding, etc.) should be routed separately and should be connected only at a single ground point.
- 2) Noise coupling can be reduced by minimizing the area circumscribed by current loops. This applies particularly to loops where high pulsed currents flow.
- 3) For high current paths, the traces should be doubled on the other side of the PCB whenever possible: this will reduce both the resistance

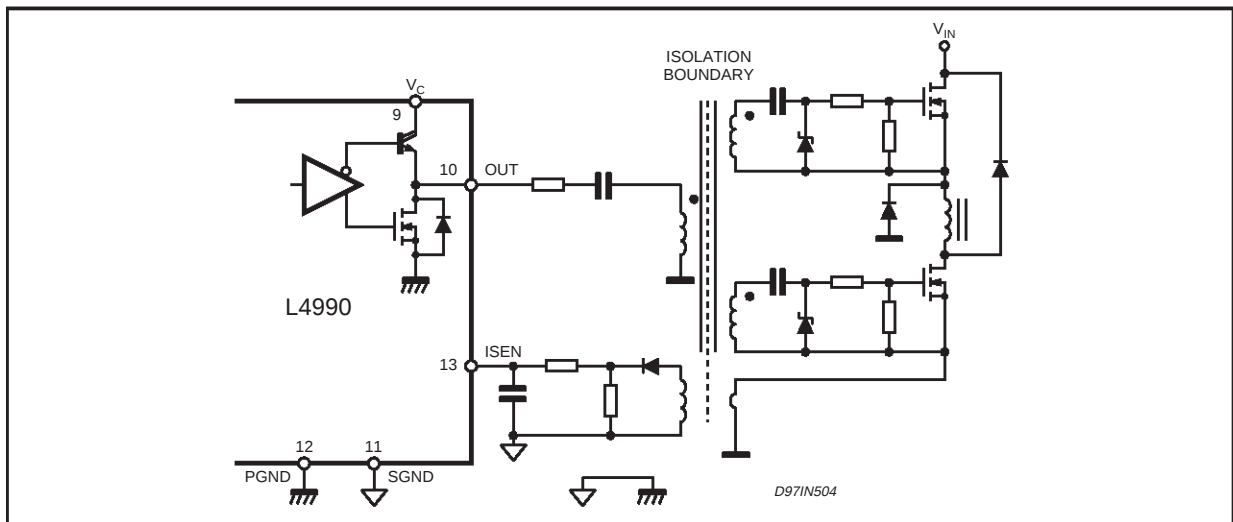
and the inductance of the wiring.

- 4) Magnetic field radiation (and stray inductance) can be reduced by keeping all traces carrying switched currents as short as possible.
- 5) In general, traces carrying signal currents should run far from traces carrying pulsed currents or with quickly swinging voltages. From this viewpoint, particular care should be taken of the high impedance points (current sense input, feedback input, ...). It could be a good idea to route signal traces on one PCB side and power traces on the other side.
- 6) Provide adequate filtering of some crucial points of the circuit, such as voltage references, IC's supply pins, etc.

#### APPLICATION IDEAS

Here follows a series of ideas/suggestions aimed at either improving performance or solving common application problems of L4990-based supplies.

**Figure 33. Isolated MOSFET Drive & Current Transformer Sensing in 2-switch Topologies.**



**Figure 34. Low consumption start-up**

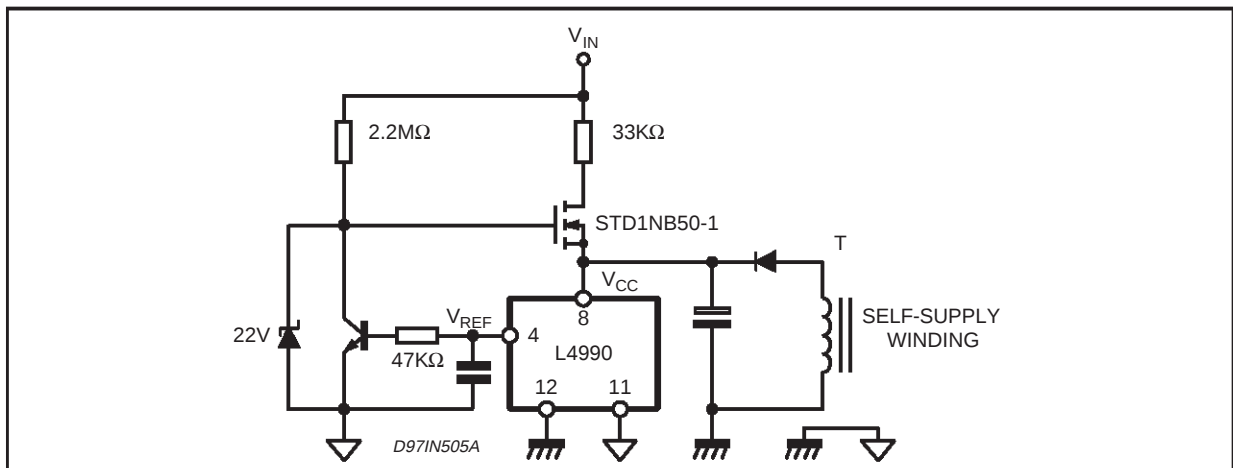


Figure 35. Bipolar Transistor Drive

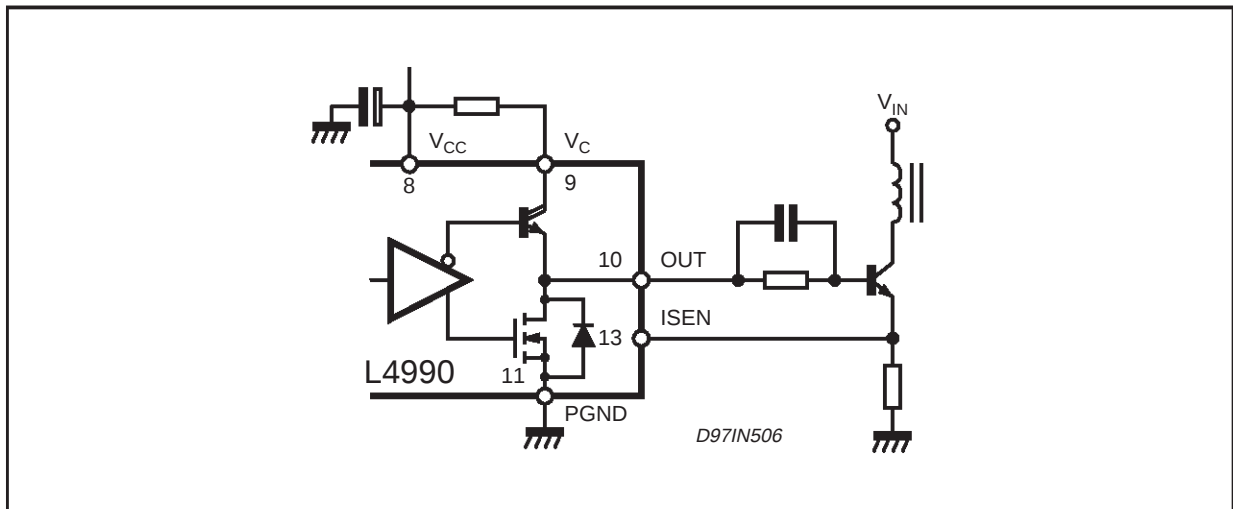


Figure 36. Typical E/A compensation networks.

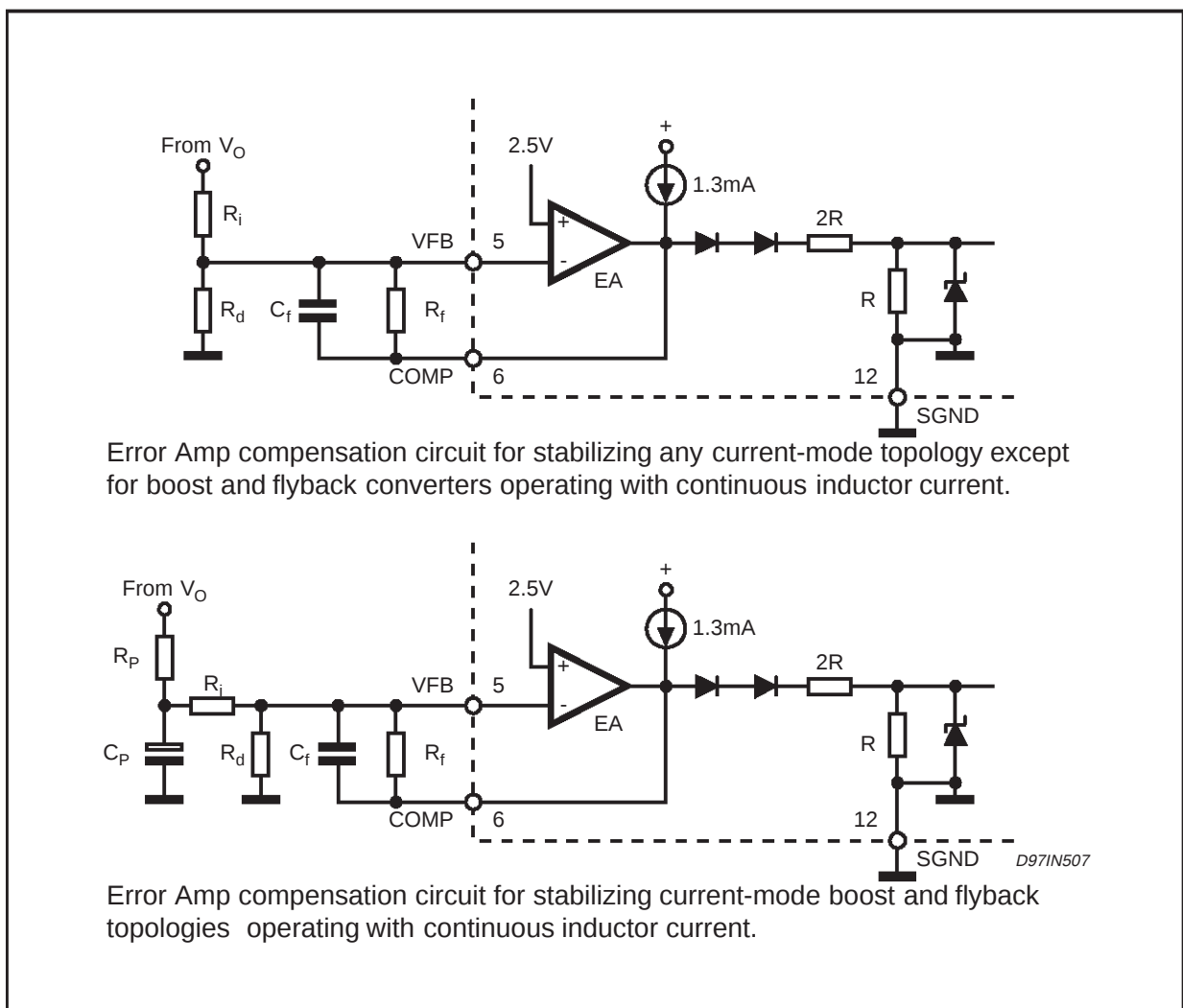


Figure 37. Feedback with optocoupler

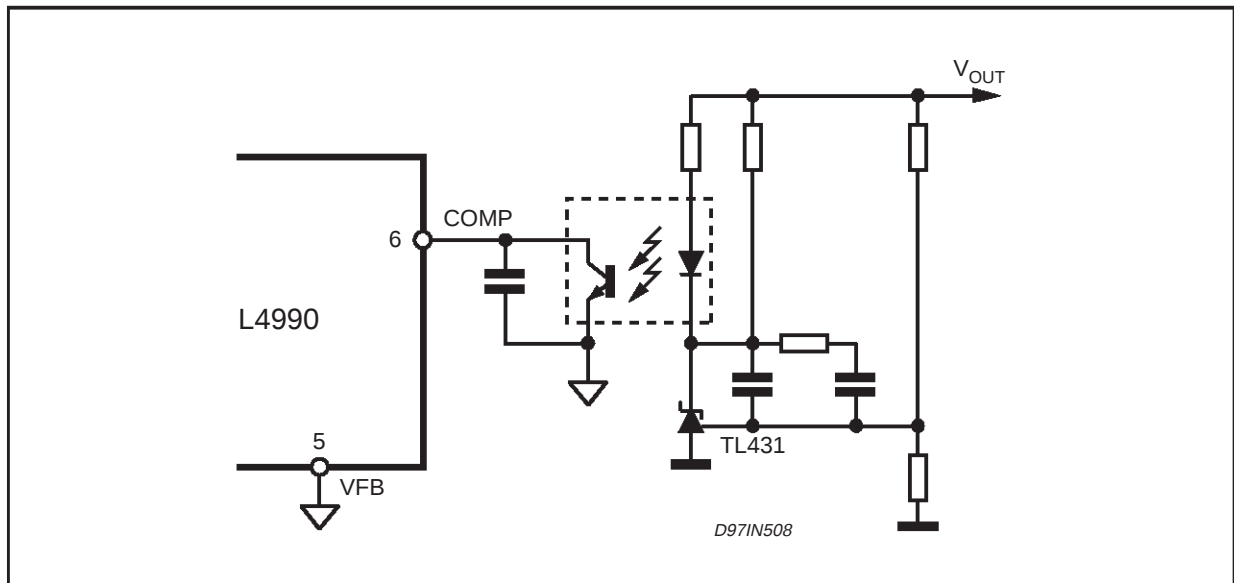


Figure 38. Slope compensation techniques

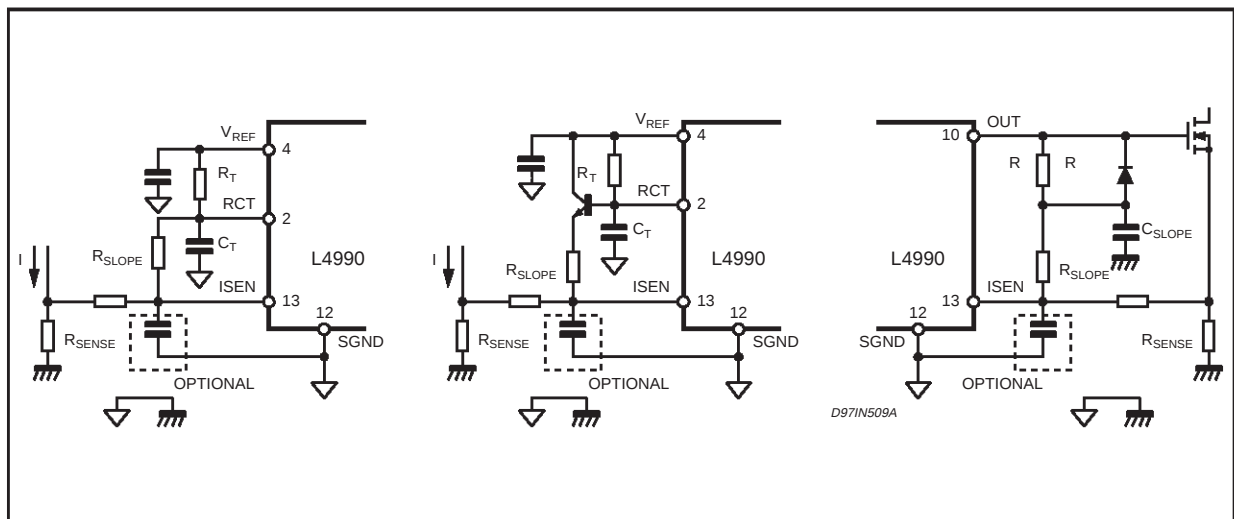


Figure 39. Protection against overvoltage/feedback disconnection (latched)

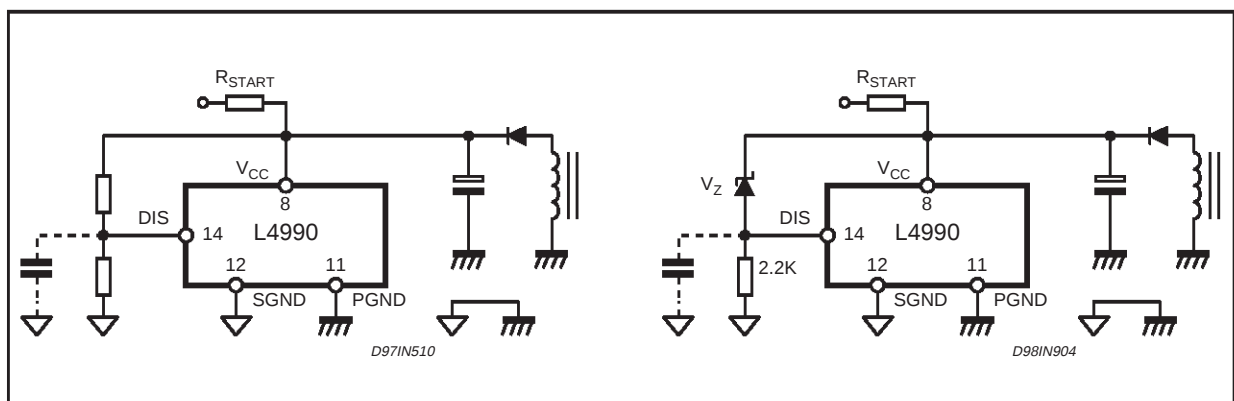


Figure 40. Protection against overvoltage/feedback disconnection (not latched)

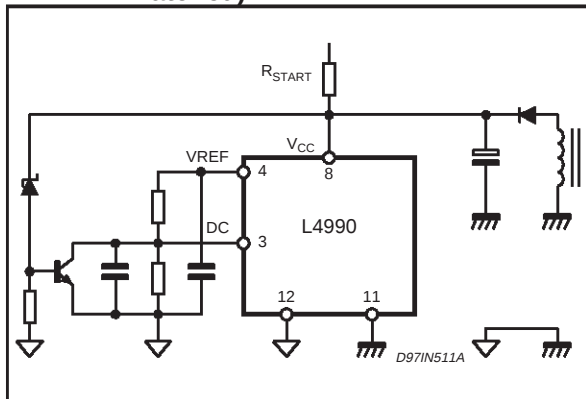


Figure 41. Device shutdown on overcurrent

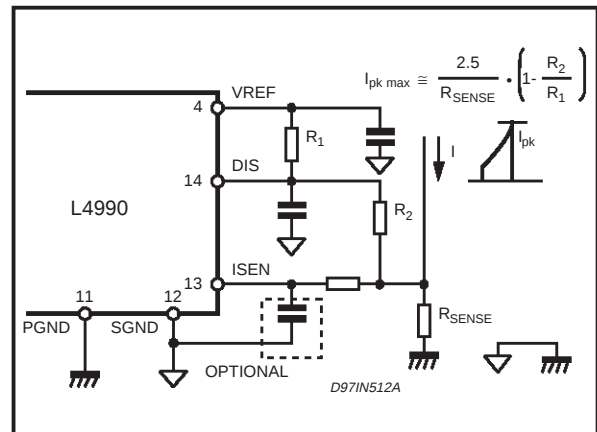


Figure 42. Constant power in pulse-by-pulse current limitation (flyback discontinuous)

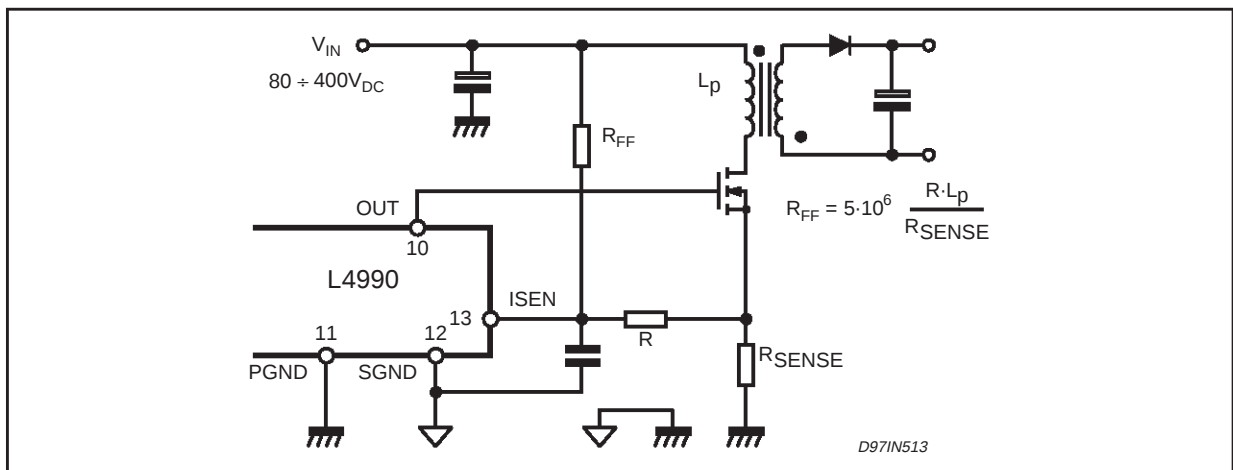
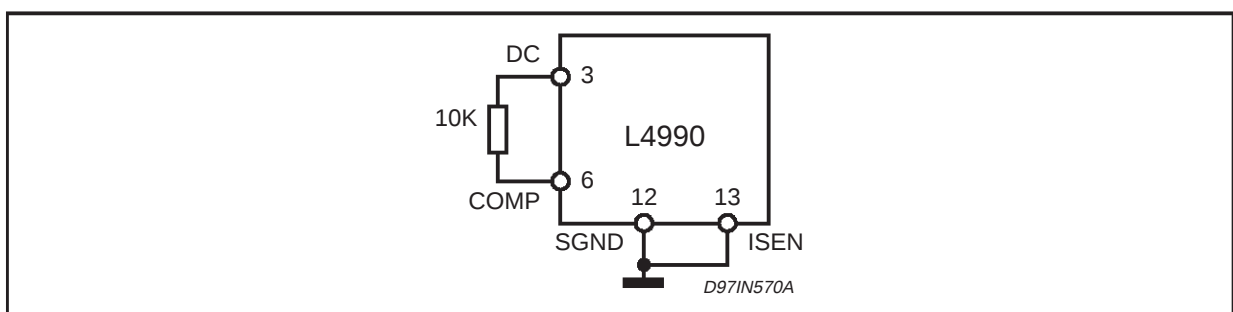


Figure 43. Voltage mode operation.

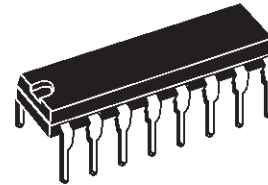


## REFERENCES

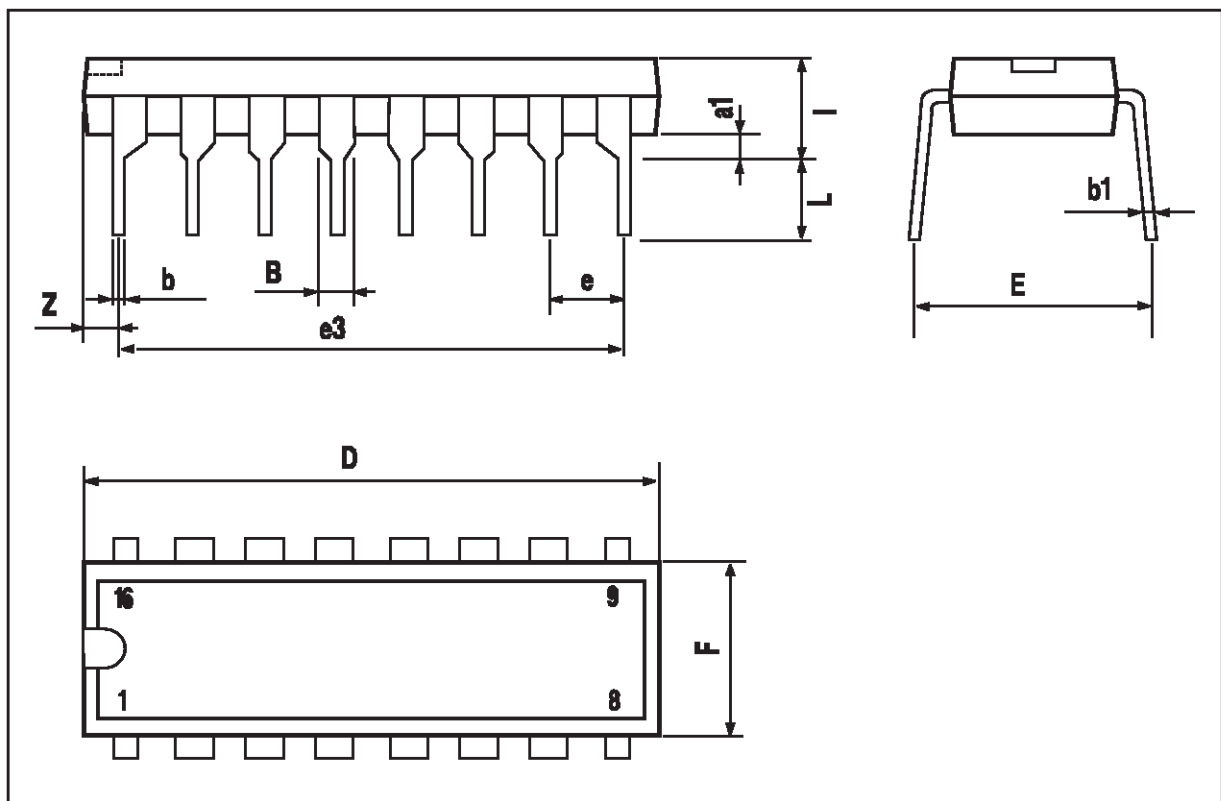
- [1] Efficient active Clamp for Off-line Applications using L4990 and L6380 (N. Tricomi, G. Gattavari, C. Adragna, PCIM96 - NURBERG).
- [2] 25W Off-Line Autoranging Battery Charger with L4990 (AN889)
- [3] 300W Secondary Controlled Two-Switch Forward Converter with L4990 (AN890)
- [4] SMPS with L4990 for Multisync Monitors (AN891)
- [5] High performance VRM using L4990A, for Pentium Pro® processor (AN908).

| DIM. | mm   |       |      | inch  |       |       |
|------|------|-------|------|-------|-------|-------|
|      | MIN. | TYP.  | MAX. | MIN.  | TYP.  | MAX.  |
| a1   | 0.51 |       |      | 0.020 |       |       |
| B    | 0.77 |       | 1.65 | 0.030 |       | 0.065 |
| b    |      | 0.5   |      |       | 0.020 |       |
| b1   |      | 0.25  |      |       | 0.010 |       |
| D    |      |       | 20   |       |       | 0.787 |
| E    |      | 8.5   |      |       | 0.335 |       |
| e    |      | 2.54  |      |       | 0.100 |       |
| e3   |      | 17.78 |      |       | 0.700 |       |
| F    |      |       | 7.1  |       |       | 0.280 |
| I    |      |       | 5.1  |       |       | 0.201 |
| L    |      | 3.3   |      |       | 0.130 |       |
| Z    |      |       | 1.27 |       |       | 0.050 |

**OUTLINE AND  
MECHANICAL DATA**

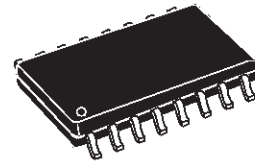


**DIP16**

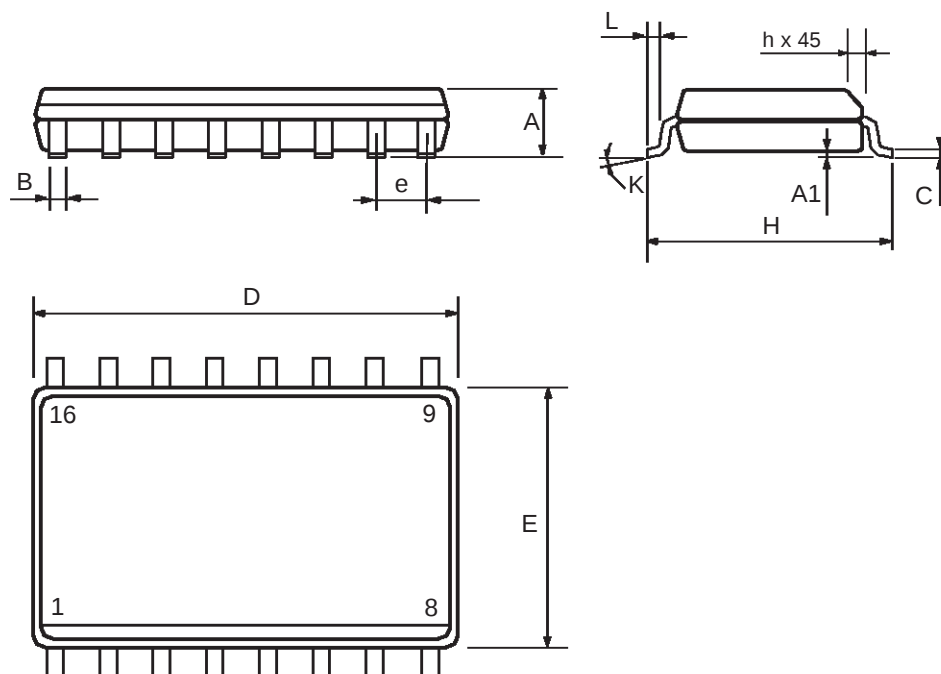


| DIM. | mm                  |      |       | inch  |       |       |
|------|---------------------|------|-------|-------|-------|-------|
|      | MIN.                | TYP. | MAX.  | MIN.  | TYP.  | MAX.  |
| A    | 2.35                |      | 2.65  | 0.093 |       | 0.104 |
| A1   | 0.1                 |      | 0.3   | 0.004 |       | 0.012 |
| B    | 0.33                |      | 0.51  | 0.013 |       | 0.020 |
| C    | 0.23                |      | 0.32  | 0.009 |       | 0.013 |
| D    | 10.1                |      | 10.5  | 0.398 |       | 0.413 |
| E    | 7.4                 |      | 7.6   | 0.291 |       | 0.299 |
| e    |                     | 1.27 |       |       | 0.050 |       |
| H    | 10                  |      | 10.65 | 0.394 |       | 0.419 |
| h    | 0.25                |      | 0.75  | 0.010 |       | 0.030 |
| L    | 0.4                 |      | 1.27  | 0.016 |       | 0.050 |
| K    | 0° (min.) 8° (max.) |      |       |       |       |       |

## OUTLINE AND MECHANICAL DATA



## SO16 Wide



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